



Thermal and Mechanical System Simulation

ANSYS CONFERENCE & 27. CADFEM USERS' MEETING

18 – 20 November 2009, Congress Center Leipzig

Evgenii Rudnyi, CADFEM GmbH

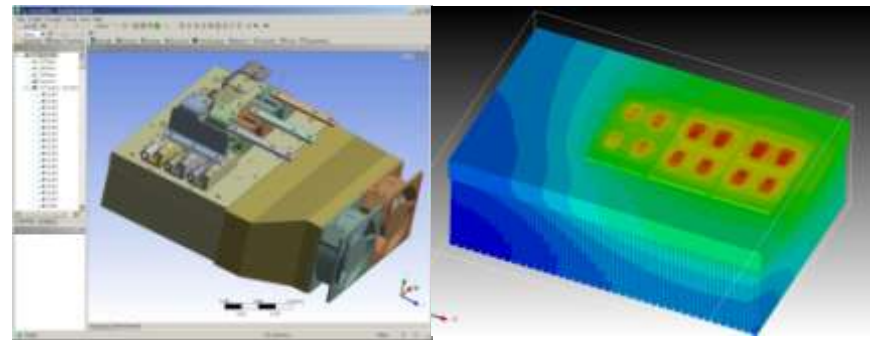
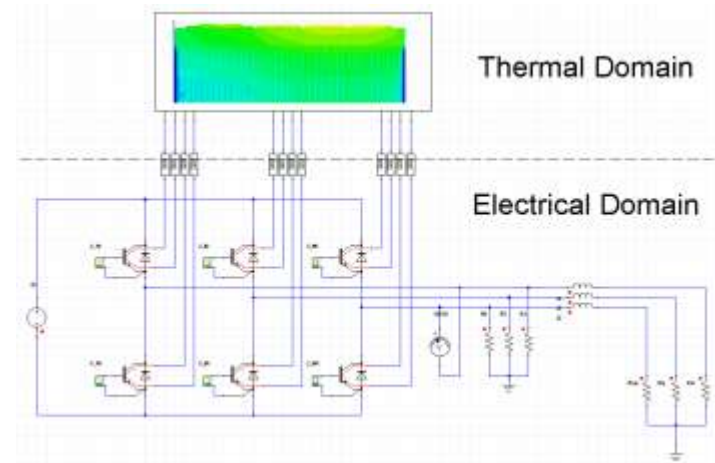
erudnyi@cadfem.de



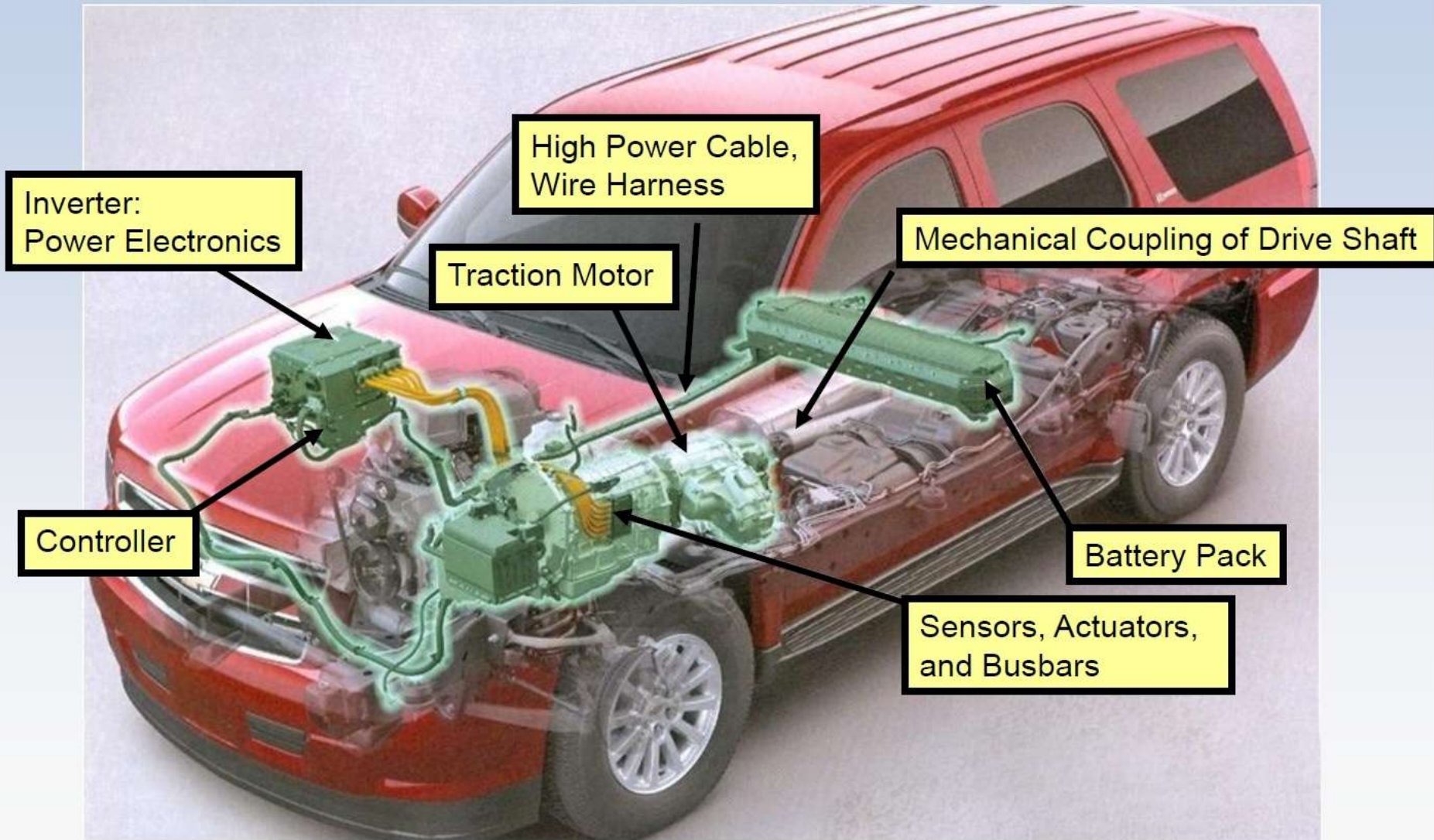
CADFEM

Outline

- System level simulation
 - Simplorer
- Coupling Workbench and Simplorer
 - Model Order Reduction
- Thermal simulation
 - Electrothermal
- Mechanical simulation
 - Control
- Other papers at ACUM

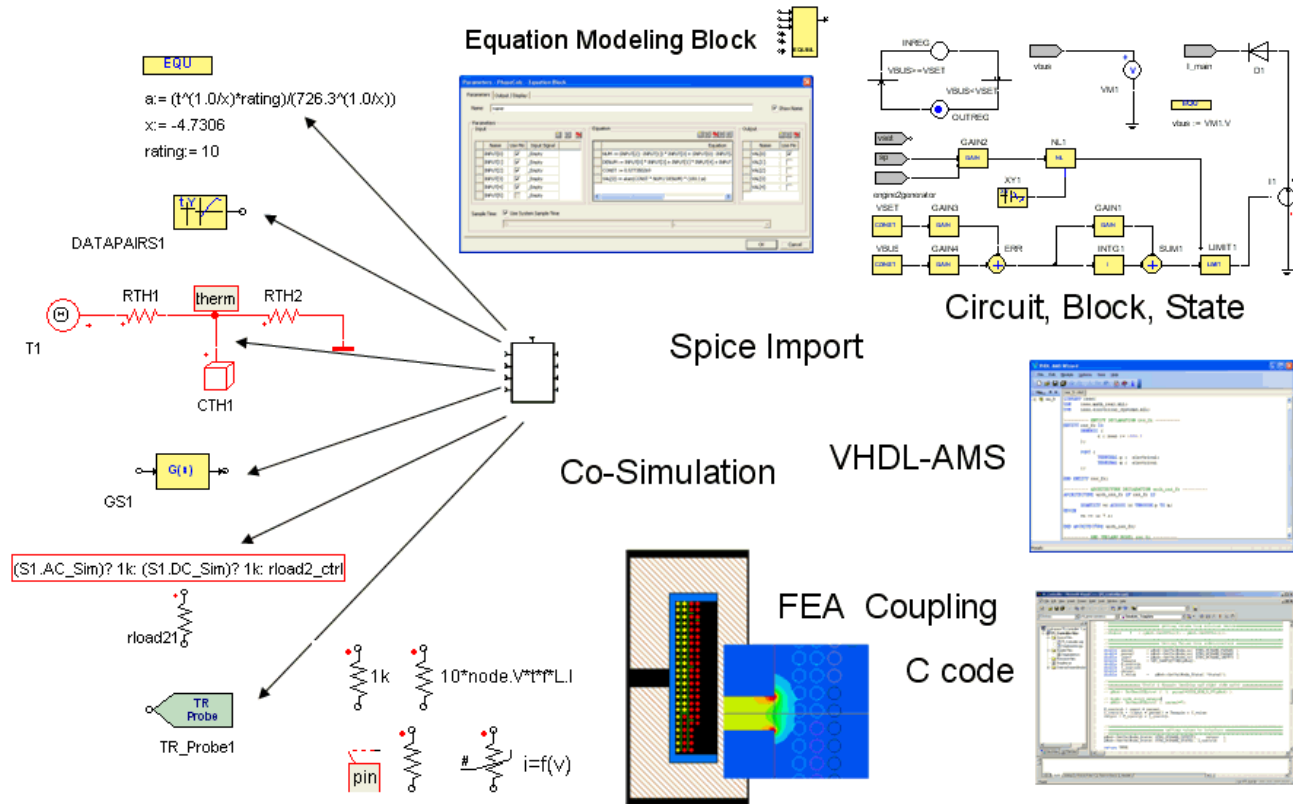


Mechatronics: mechanical + electrical + computer sciences

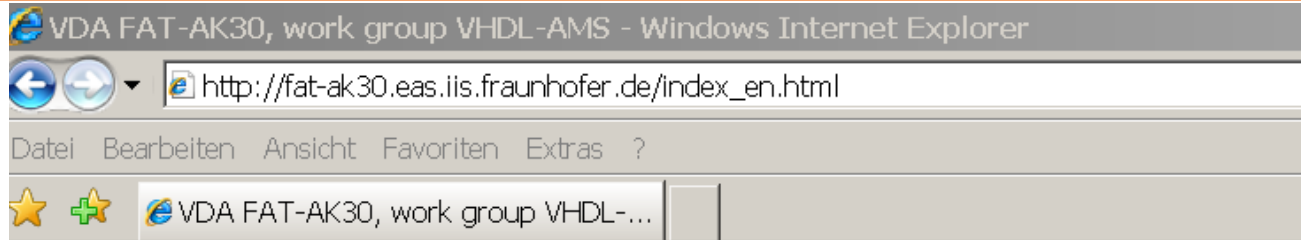


Simplorer: <http://www.ansoft.com/>

- Circuits
- Block Diagrams
- State Machines
- Equation Blocks
- VHDL-AMS



Example of VHDL-AMS



■ VDA FAT-AK30

[General Survey](#)

[Projects and Documents](#)

[Publications](#)

[Model Libraries](#)

[SAE J2748 \(Download\)](#)

[Symbol Exchange](#)

[Internal](#)

Association of the Automotive Industry (VDA)

German Association for Research in Automobile Technology (FAT)

VDA

FAT-AK30

Working Group: Simulation of Mixed Systems with VHDL-AMS



Innovation cycles in automotive industry have become shorter and shorter during the last ten years accompanied by increased complexity of systems. For this reason simulation has become a standard method within the process of product development. To reduce costs and time, an easy model exchange between manufactures and suppliers based on a standardized modeling language is necessary.

VHDL-AMS is a standardized hardware description language to model and simulate digital, analog, and mixed-signal systems consisting of electrical and nonelectrical parts. Major German car manufacturers and suppliers are checking the suitability of the language for real world heterogeneous automotive systems.

The VDA/FAT Working Group AK 30 "Simulation of Mixed Systems with VHDL-AMS" is organized within the Association for Research in Automobile Technology (FAT - Forschungsvereinigung Automobiltechnik) of the German Association of the Automotive Industry (VDA - Verband der Automobilindustrie). It promotes the relationship between car manufactures and their suppliers concerning simulation of mixed systems and model exchange.

► [Further information about model libraries](#)

VHDL-AMS = Very High Speed Integrated Circuit Hardware Description Language - Analog and Mixed Signal

Compact Modeling: Transistor Compact Model

$$I_E = I_{F0}(e^{qV_{EB}/kT} - 1) - \alpha_R I_{R0}(e^{qV_{CB}/kT} - 1)$$

$$I_E = \alpha_F I_{F0}(e^{qV_{EB}/kT} - 1) - I_{R0}(e^{qV_{CB}/kT} - 1)$$

Too much reliance
on intuition

$$-\epsilon \nabla^2 \Psi = q(p - n + N_0)$$

$$\frac{\partial n}{\partial t} = \nabla \cdot (-\mu_n n \nabla \Psi + D_n \nabla n) - R_n$$

$$\frac{\partial p}{\partial t} = \nabla \cdot (\mu_p p \nabla \Psi + D_p \nabla p) - R_p$$

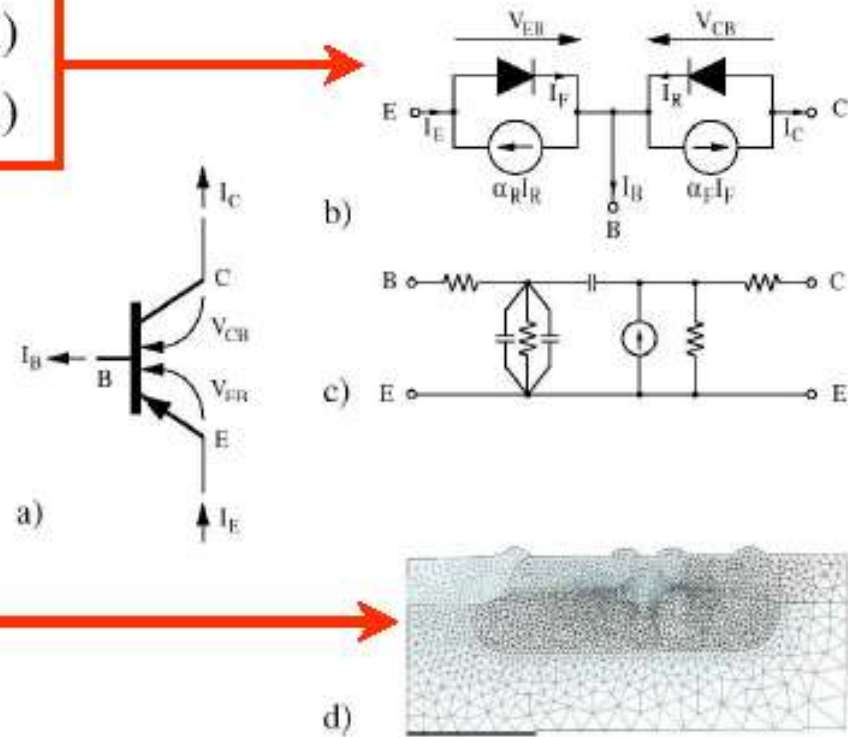
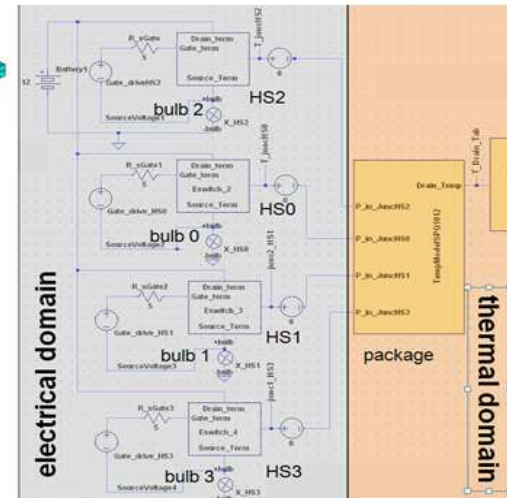
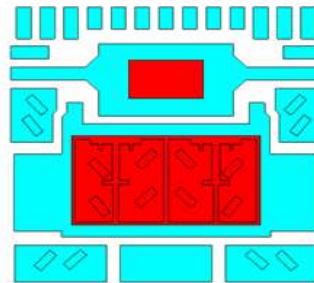
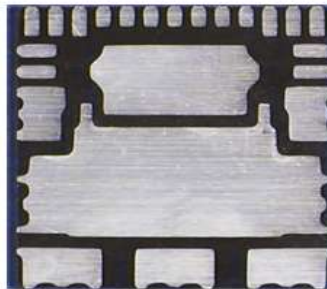
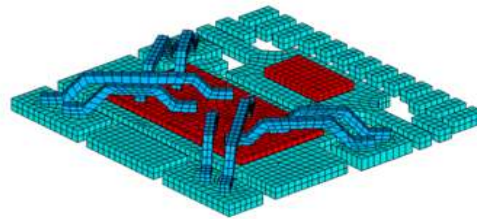
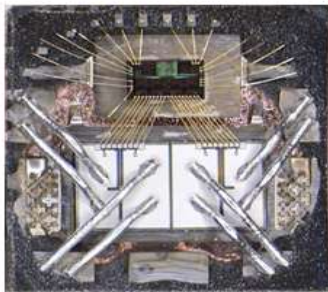


Figure from J. Lienemann, E. B. Rudnyi and J. G. Korvink. MST MEMS model order reduction: Requirements and Benchmarks. Linear Algebra and its Applications, v. 415, N 2-3, p. 469-498, 2006.

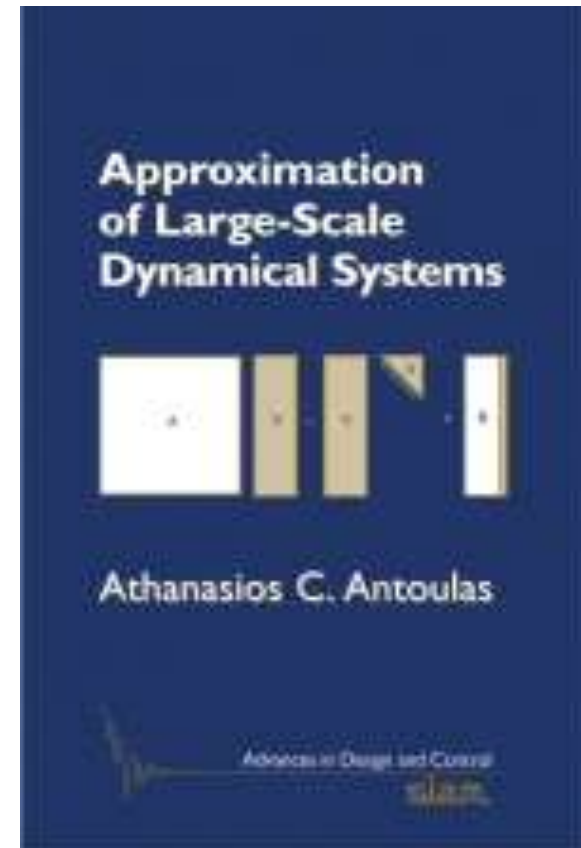
From Finite Elements to System Simulation



- Electrothermal Simulation with power MOSFET:
 - From ANSYS Workbench to Simplorer

Model Order Reduction

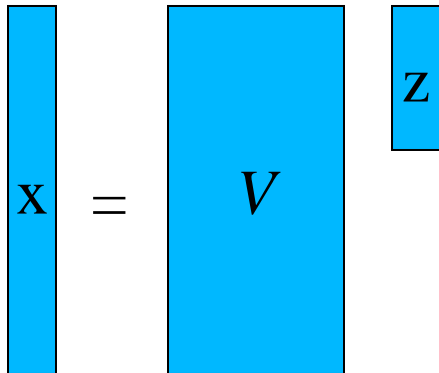
- Relatively new technology
- Solid mathematical background:
 - Approximation of large scale dynamic systems
- Dynamic simulation:
 - Harmonic or transient simulation
- Industry application level:
 - Linear dynamic systems



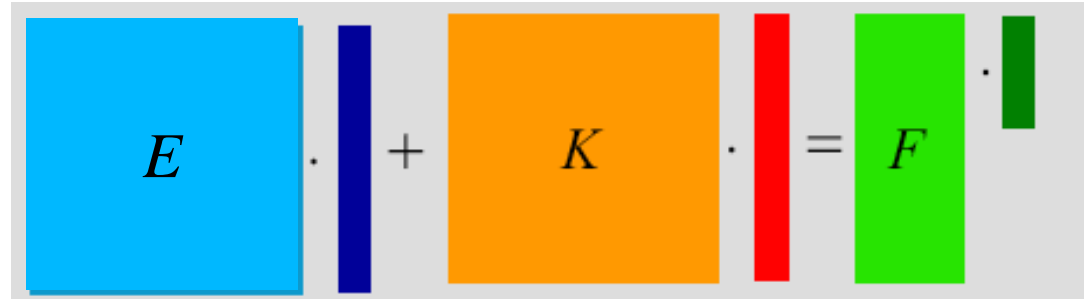
Model Reduction as Projection

- Projection onto low-dimensional subspace

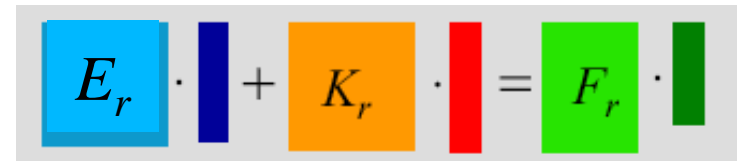
$$\mathbf{x} = V\mathbf{z} + \boldsymbol{\varepsilon}$$



$$E\dot{\mathbf{x}} + K\mathbf{x} = B\mathbf{u}$$



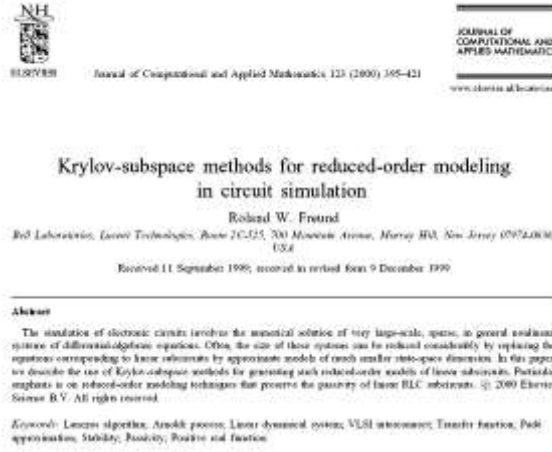
$$V^T E V \dot{\mathbf{z}} + V^T K V \mathbf{z} = V^T B \mathbf{u}$$



- How to find subspace?
- Mode superposition is not the best way to do it.

Implicit Moment Matching

- Padé approximation
- Matching first moments for the transfer function



- Implicit Moment Matching:
 - via Krylov Subspace

$$E\dot{\mathbf{x}} + K\mathbf{x} = B\mathbf{u}$$

$$H(s) = (sE + K)^{-1} B$$

$$H = \sum_0^{\infty} m_i (s - s_0)^i$$

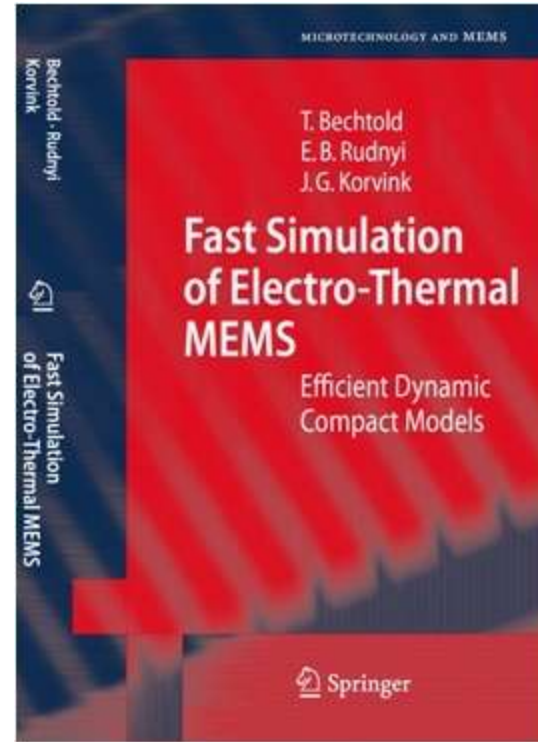
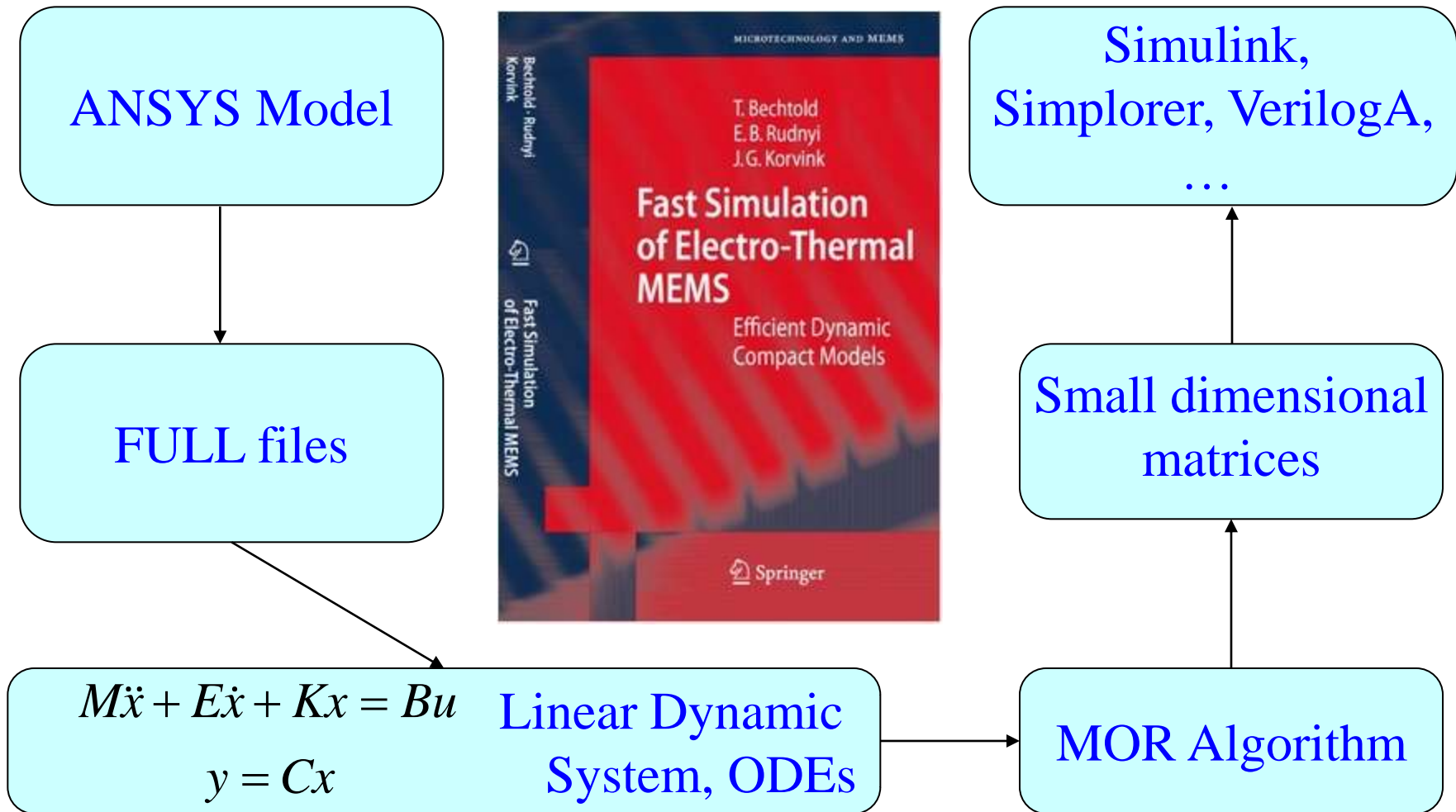
$$H_{red} = \sum_0^{\infty} m_{i,red} (s - s_0)^i$$

$$m_i = m_{i,red}, \quad i = 0, \dots, r$$

$$s_0 = 0$$

$$V = \text{span}\{\mathfrak{I}(K^{-1}E, K^{-1}b)\}$$

MOR for ANSYS: <http://ModelReduction.com>

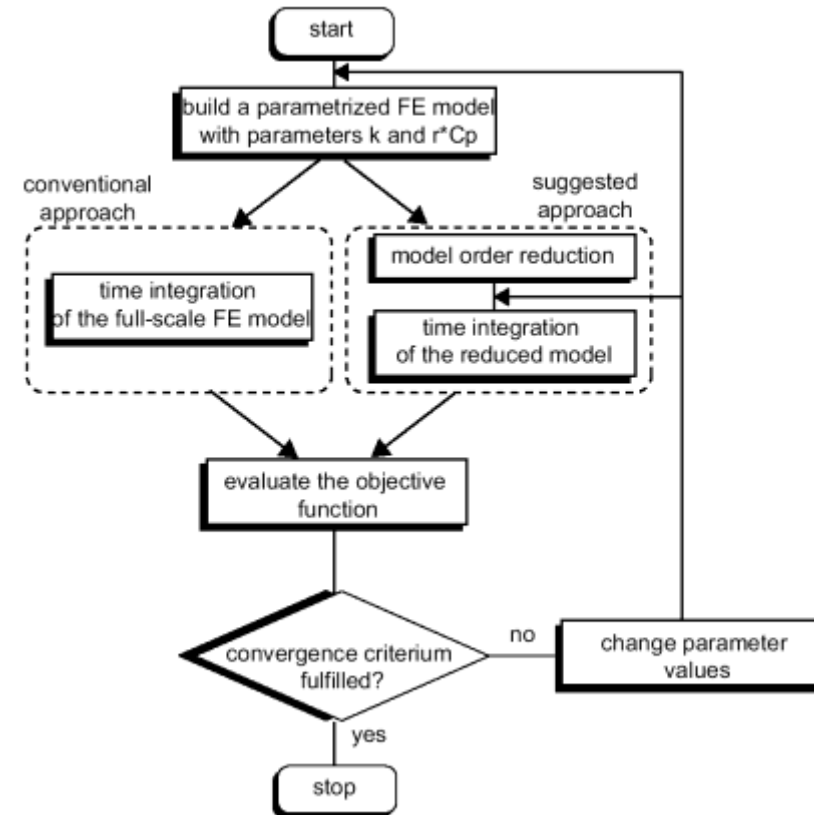


Current version 2.5

MOR for ANSYS Timing: MOR as Fast Solver

- Reduced model of dimension 30

Dimension, DoFs	nnz	MOR Time /ANSYS static
4 267	20 861	1.4
11 445	93 781	1.8
20 360	265 113	1.7
79 171	2 215 638	1.5
152 943	5 887 290	2.2
180 597	7 004 750	1.9
375 801	15 039 875	1.7



System Thermal Simulation in Simplorer

- Current : Heat Flow
- Voltage : Temperature
- Resistor : Thermal resistance
- Capacitor : Thermal capacitor
- Voltage source : Temperature source
- Current source : Heat Flow source

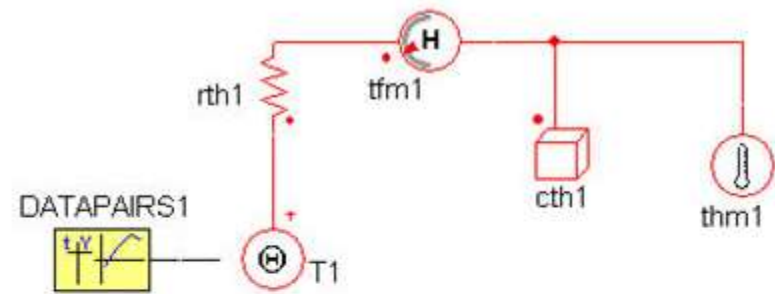


Figure 1. Application examples of the VHDL-AMS Temperature Source

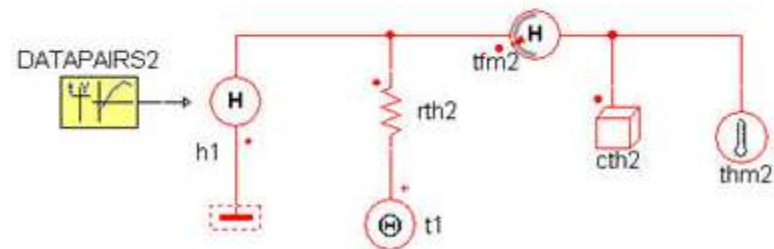
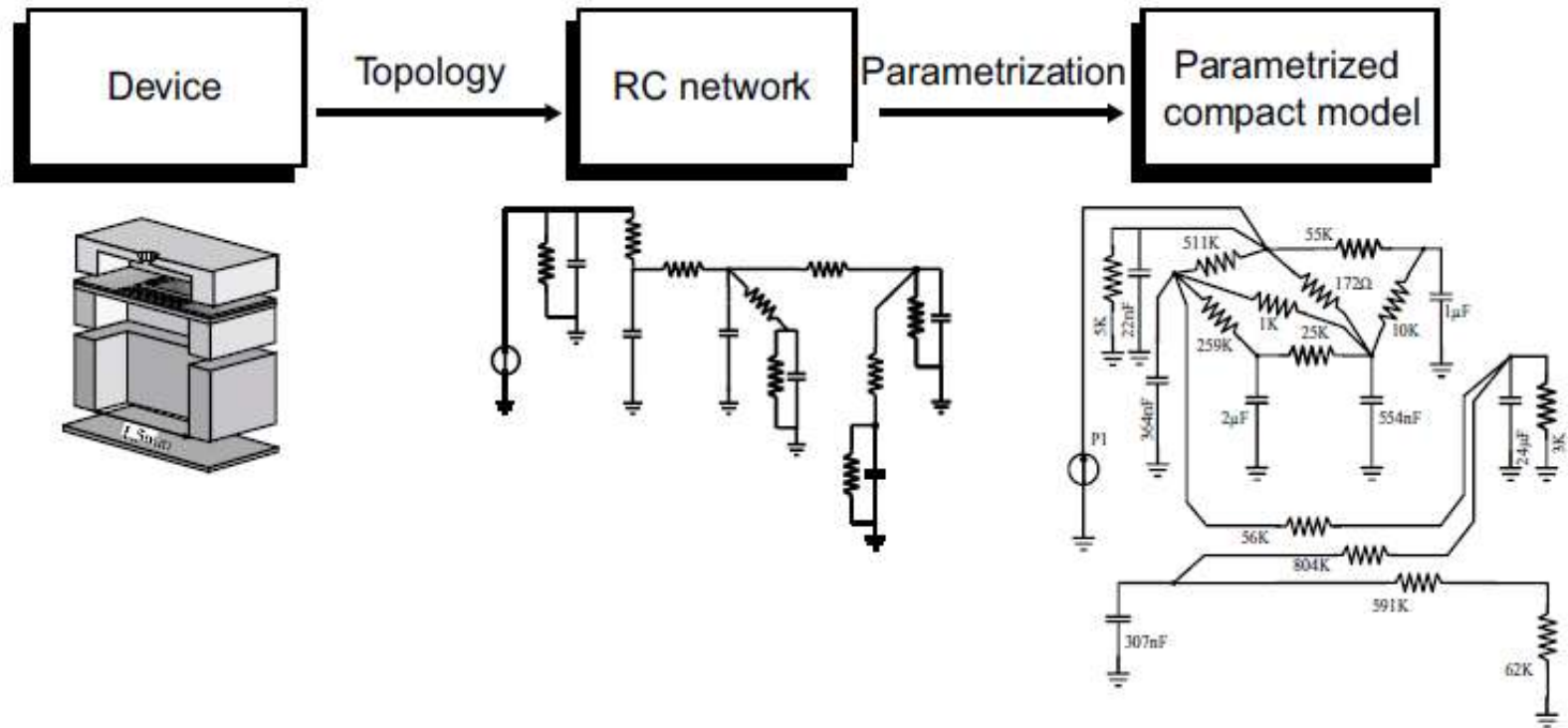


Figure 2. Application examples of the VHDL-AMS Heat Flow Source

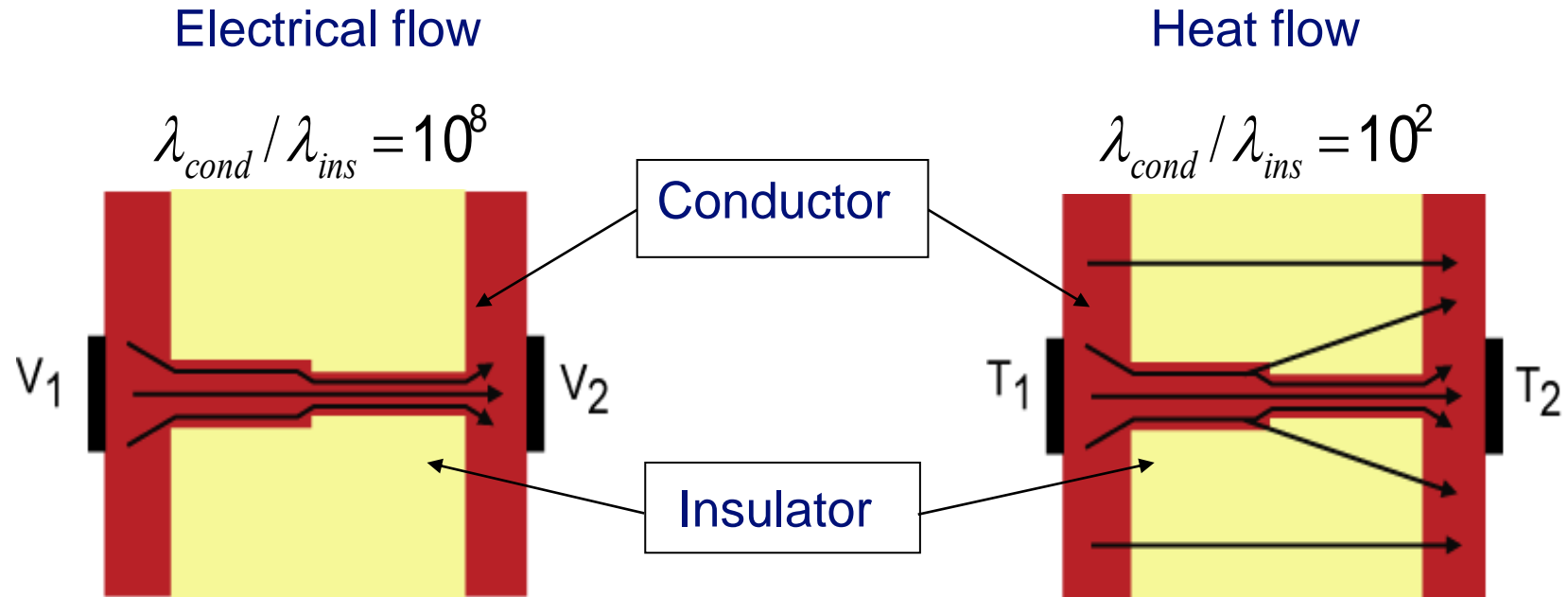
Compact Thermal Models



- Looks understandable – but how to do it in practice?

Figure from the book “*Fast Simulation of Electro-Thermal MEMS: Efficient Dynamic Compact Models.*” Springer, 2006.

Electrical vs. Thermal

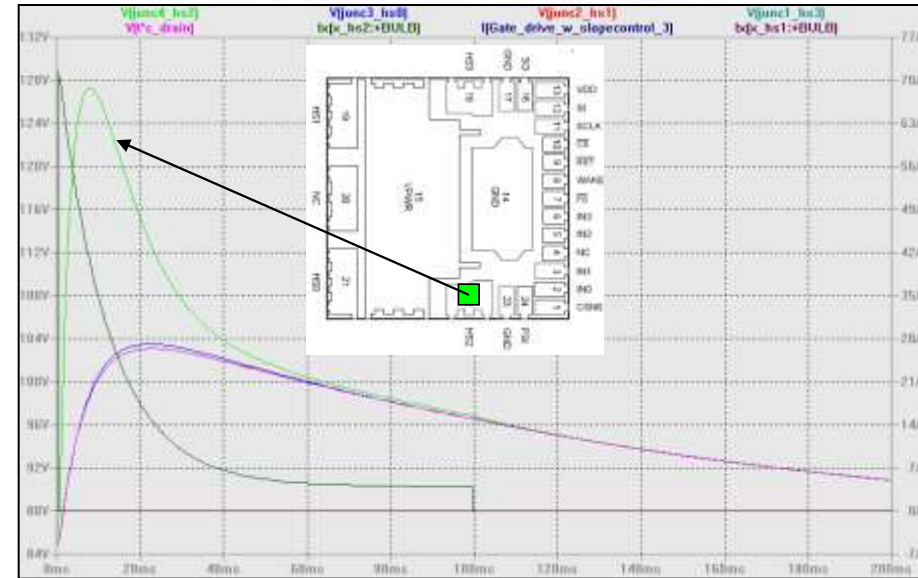
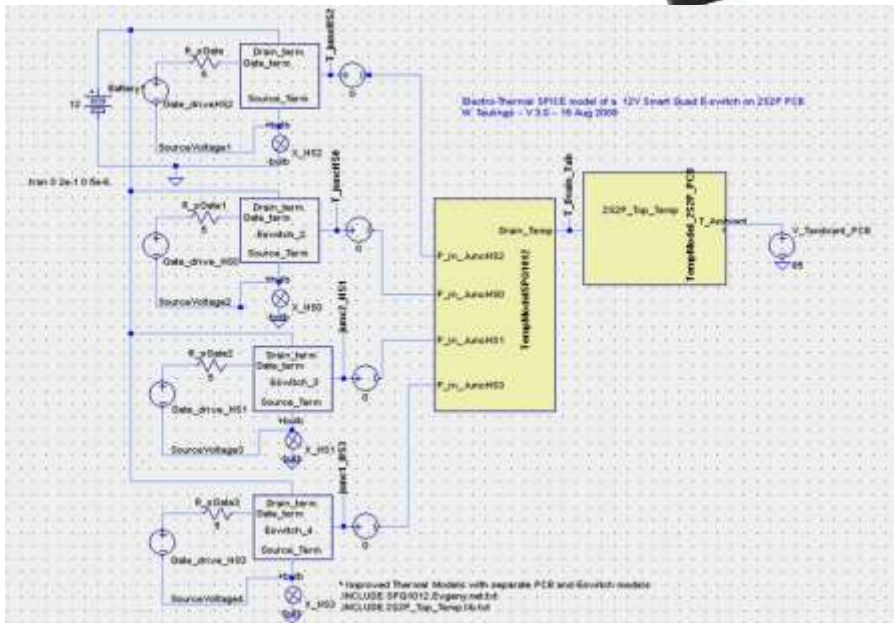
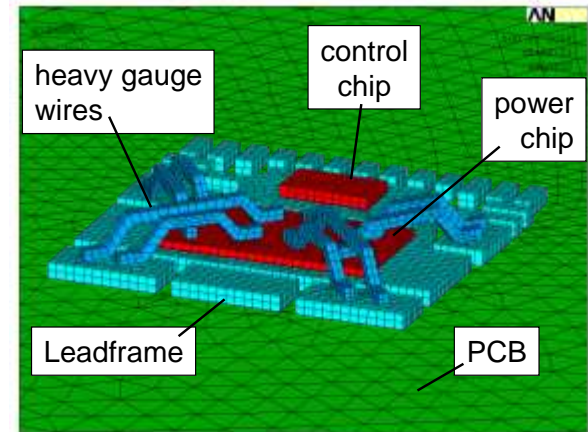


- Thermal phenomena are much more distributed, it is hard to lump them.

Figure from the book “*Fast Simulation of Electro-Thermal MEMS: Efficient Dynamic Compact Models.*” Springer, 2006.

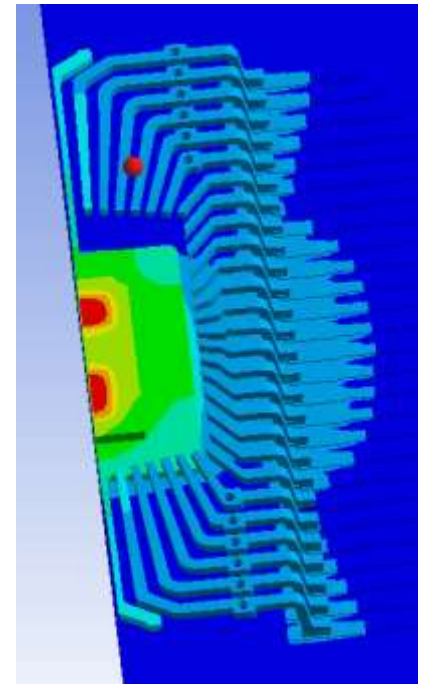
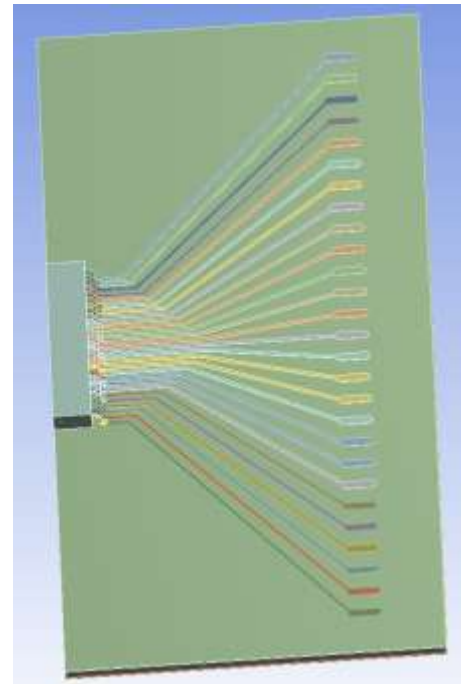
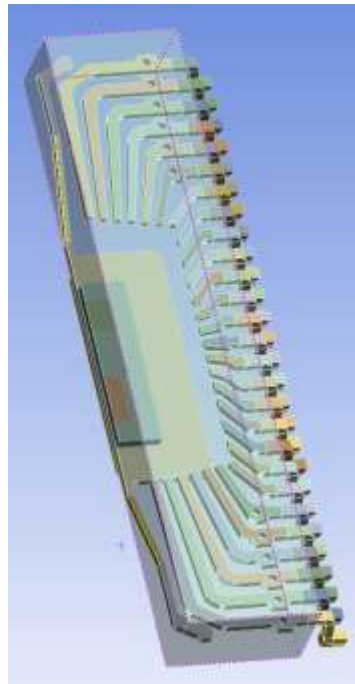
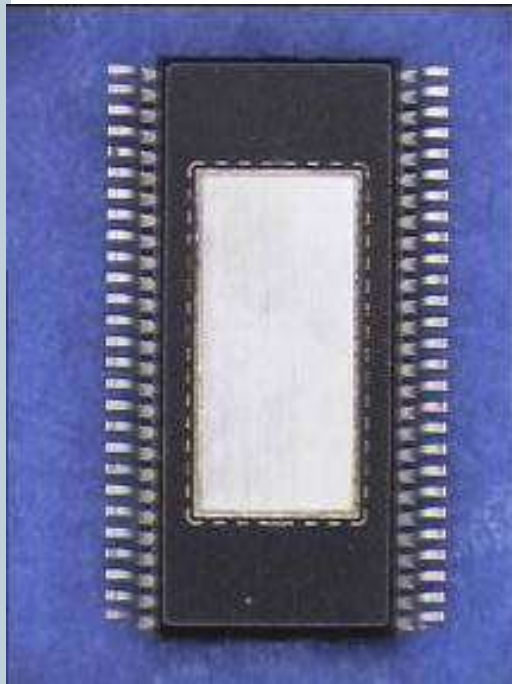
Freescale Multi-channel Power Devices

MOR for ANSYS at
Therminic 2009



More information: Thursday 09:20 - 09:40 Thermoelectric System
simulation: Compact Model Simulation with ANSYS Workbench, Freescale

Chip and its Model in Workbench



- Two power MOSFET transistors

Interface to call MOR for ANSYS in Workbench

The screenshot displays the ANSYS Workbench interface for a project named "DUALMERLOT_half". The interface is divided into two main sections.

Left Section: Named Selections

- Outline for "Named Selections":**
 - Project
 - Model
 - Geometry
 - Connections
 - Mesh
 - Named Selections
 - T1
 - T2
 - Steady-State Thermal
 - GetMatrices
 - Initial Condition
 - Analysis Settings
 - Temperature
 - Commands
 - Solution
 - Solution Information
 - Temperature
 - Reaction Probe

Right Section: Commands

- Outline for "Commands":**
 - Project
 - Model
 - Geometry
 - Connections
 - Mesh
 - Named Selections
 - Steady-State Thermal
 - GetMatrices
 - Initial Condition
 - Analysis Settings
 - Temperature
 - Commands
 - Solution
 - Solution Information
 - Temperature
 - Reaction Probe

Command Window:

```
!Information about heat sources
Nnames = 2
*dim, names, char, Nnames
names(1) = 'T1', 'T2'

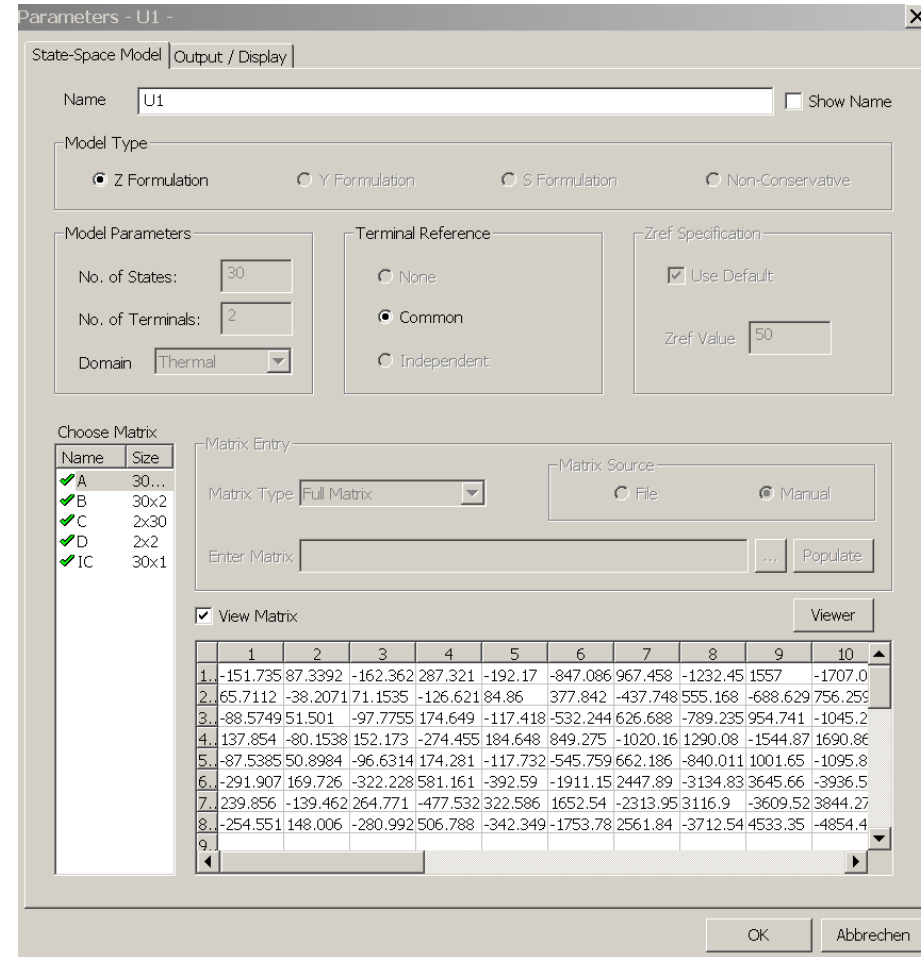
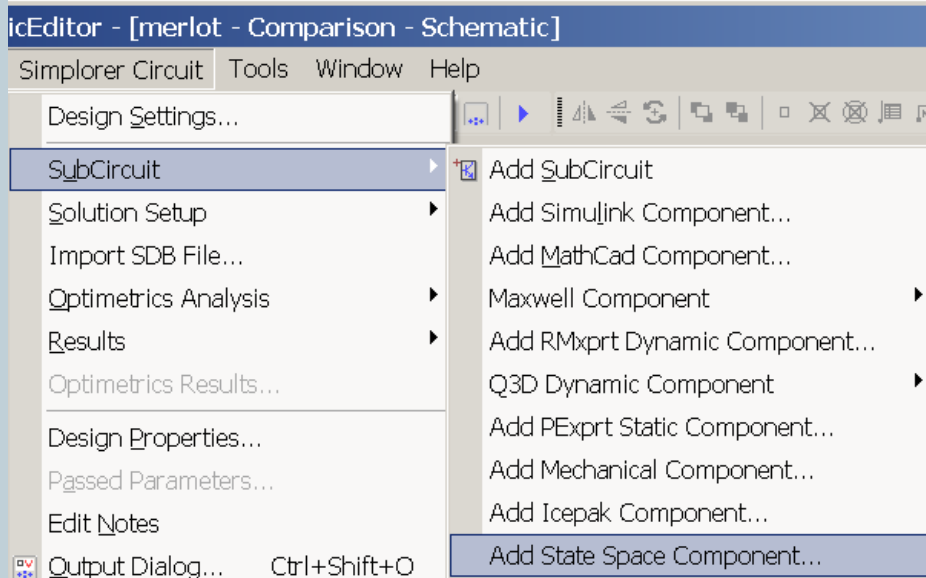
*dim, outn, array, Nnames

fini
/filename, fmain
/solu
allse
antype, harmic
eqslv, sparse
harfrq, 1/2/3.141592653589793
nsubst, 1
wrfull, 1
solve
fini
!
/filename, fstatic
/solu
allse
antype, static
eqslv, sparse
nsubst, 1
wrfull, 1
solve
fini

*do, ii, 1, Nnames
  /prep7
  cmsel, s, names(ii), elem
  vol = 0
  *get, nelem, elem, 0, count
  *get, nn, elem, 0, num, min
  *do, i, 1, nelem
    *get, vi, elem, nn, volu
```

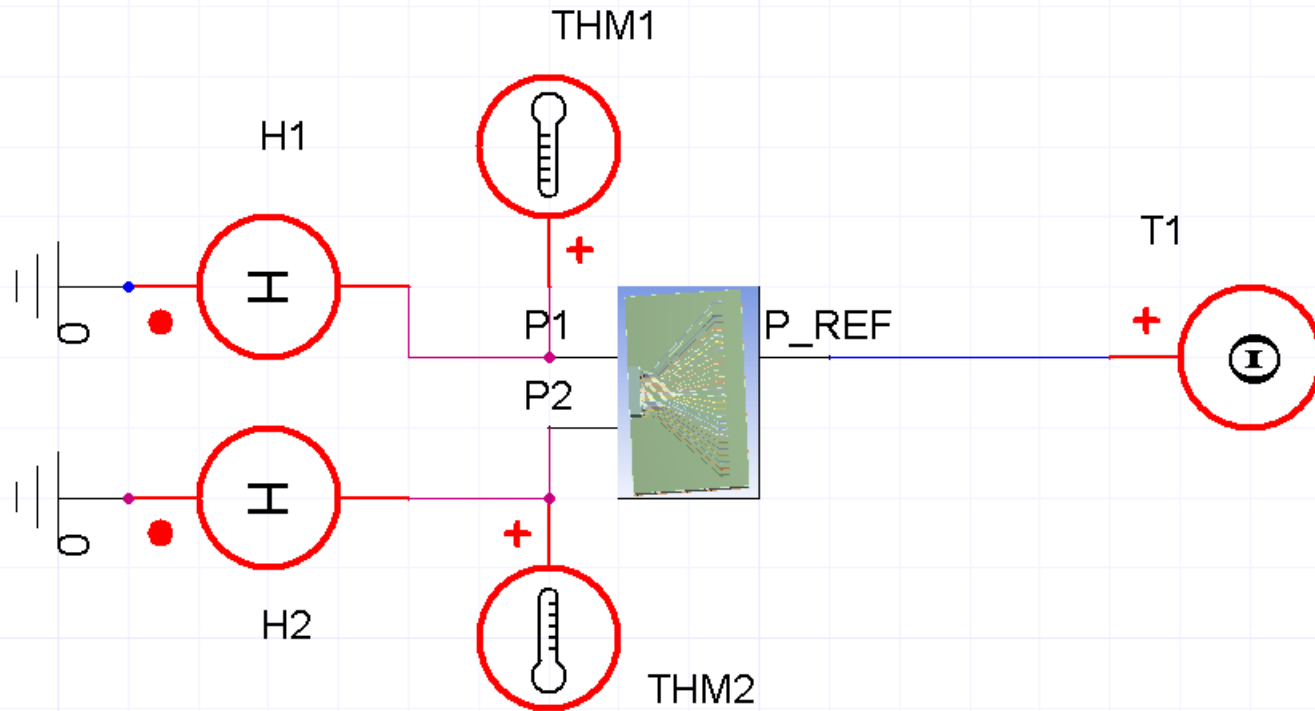
Import Reduced Model in Simplorer

- Simplorer supports state space model



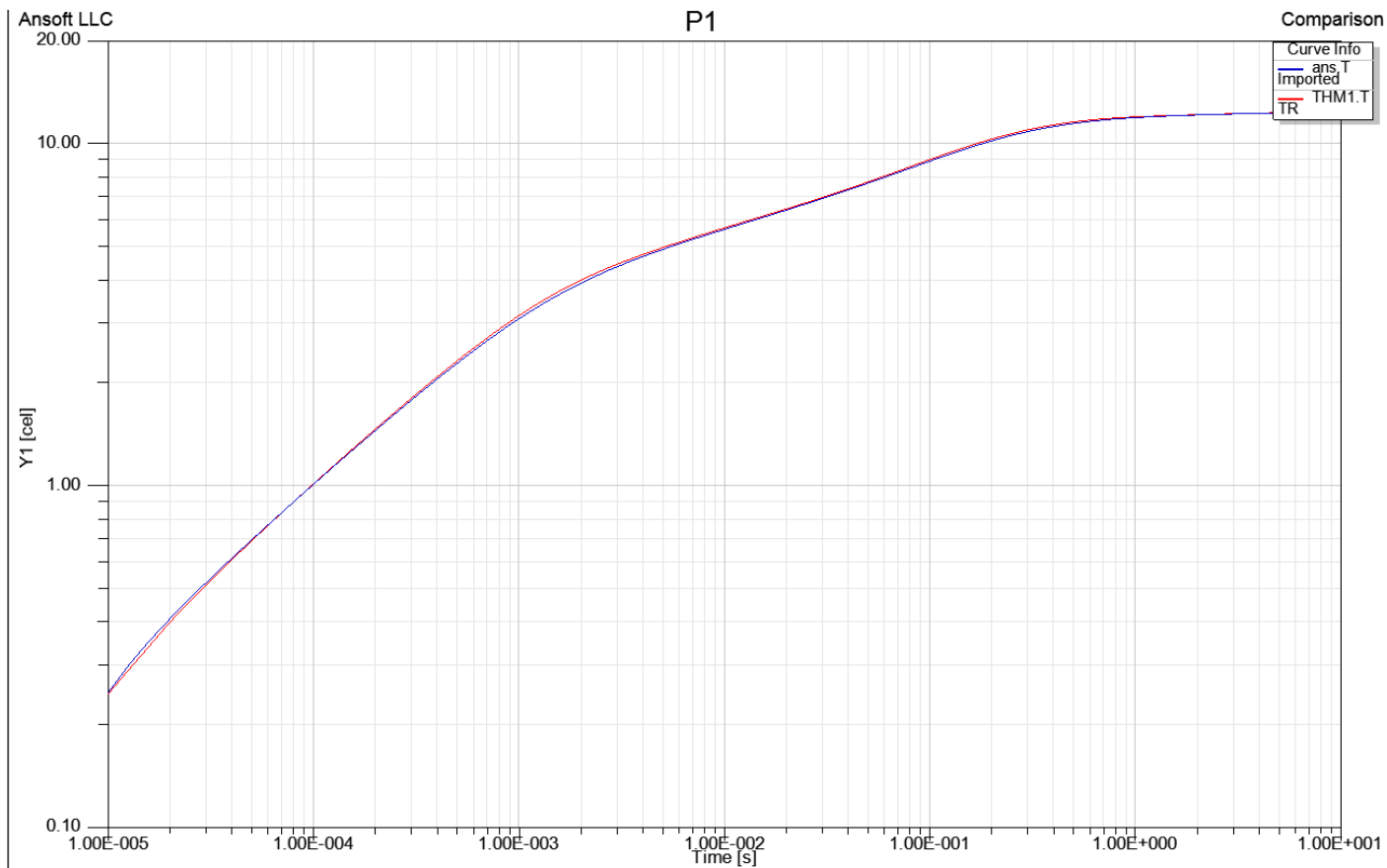
Test Thermal Circuit in Simplorer

- Conservative thermal subsystem in Simplorer
 - Voltage – Temperature
 - Current – Heat flow



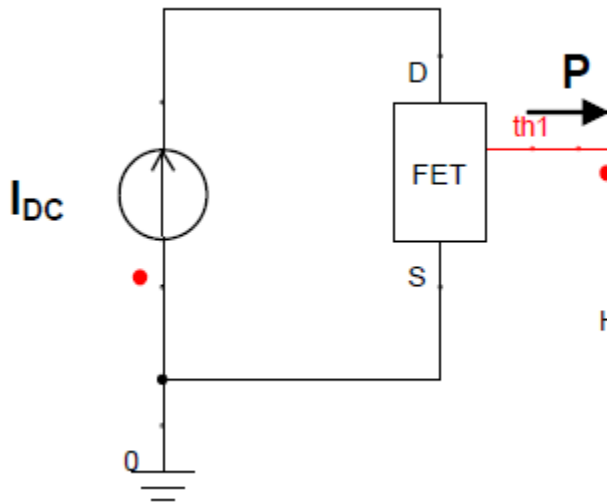
Thermal Impedance and Comparison with ANSYS

- ANSYS: about 300 000 DoFs, Reduced model: 30 DoFs
 - The difference is less than 1%
 - Timing: 60 timesteps is about 30 min in ANSYS



Thermal Runaway

- Transistor is considered as temperature dependent R_{DSon}
 - The VHDL-AMS model



```
LIBRARY IEEE;
USE IEEE.ELECTRICAL_SYSTEMS.ALL;
USE IEEE.THERMAL_SYSTEMS.ALL;

ENTITY RDS_MODEL IS
  PORT (
    QUANTITY RDS1 : RESISTANCE := 0.035;
    QUANTITY t0 : IN TEMPERATURE := 298.0;
    QUANTITY KC1 : REAL := 0.35e-3;
    QUANTITY CTRL : REAL := 0.0;
    TERMINAL th1 : thermal;
    TERMINAL p,m : ELECTRICAL);
END ENTITY RDS_MODEL;

ARCHITECTURE behav OF RDS_MODEL IS
  QUANTITY v ACROSS i THROUGH p TO m;
  QUANTITY t_val ACROSS h THROUGH th1 TO thermal_ref;
BEGIN
  IF (CTRL <= 0.0) USE
    i == 0.0;
    h == 0.0;
  ELSE
    v == i*(RDS1+KC1*(t_val-t0));
    h == -i*v;
  END USE;
END ARCHITECTURE behav;
```

Thermal Runaway Model

- Conservative coupling between electrical and thermal part

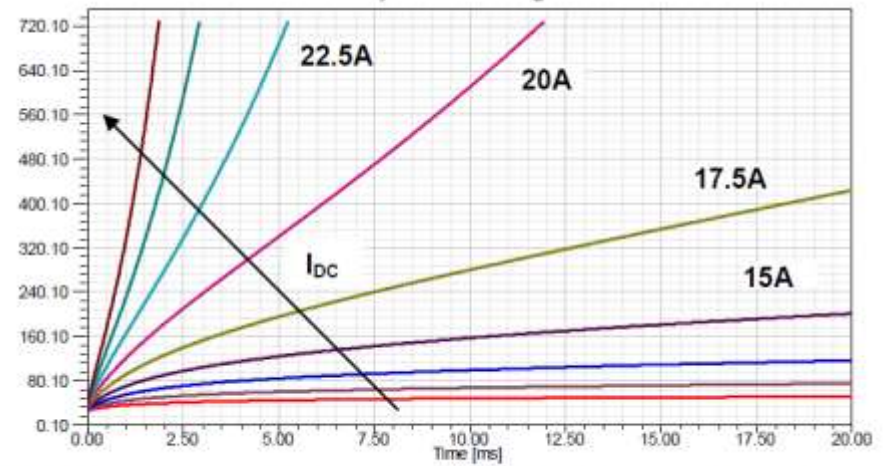
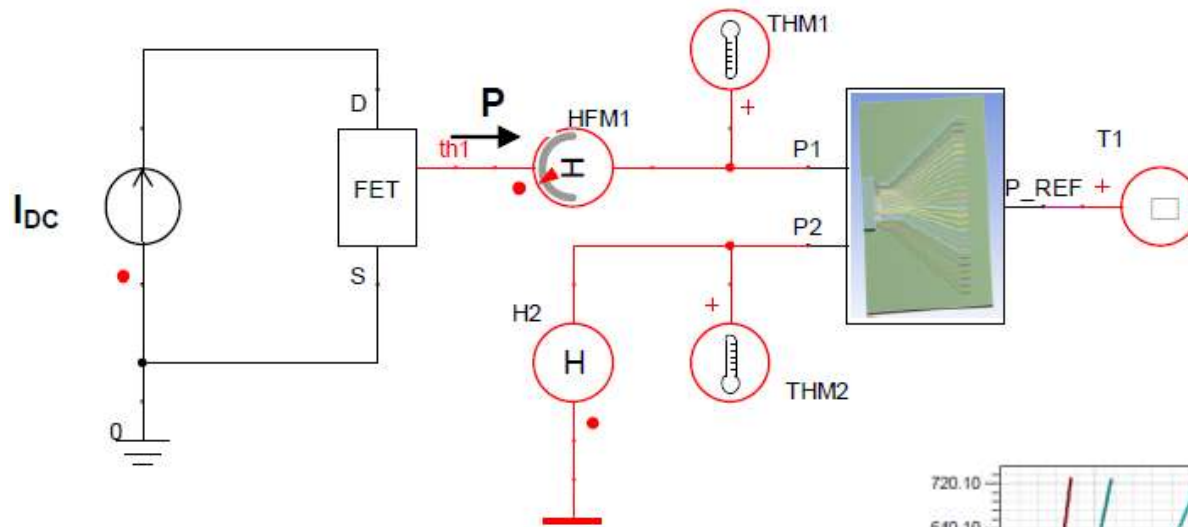
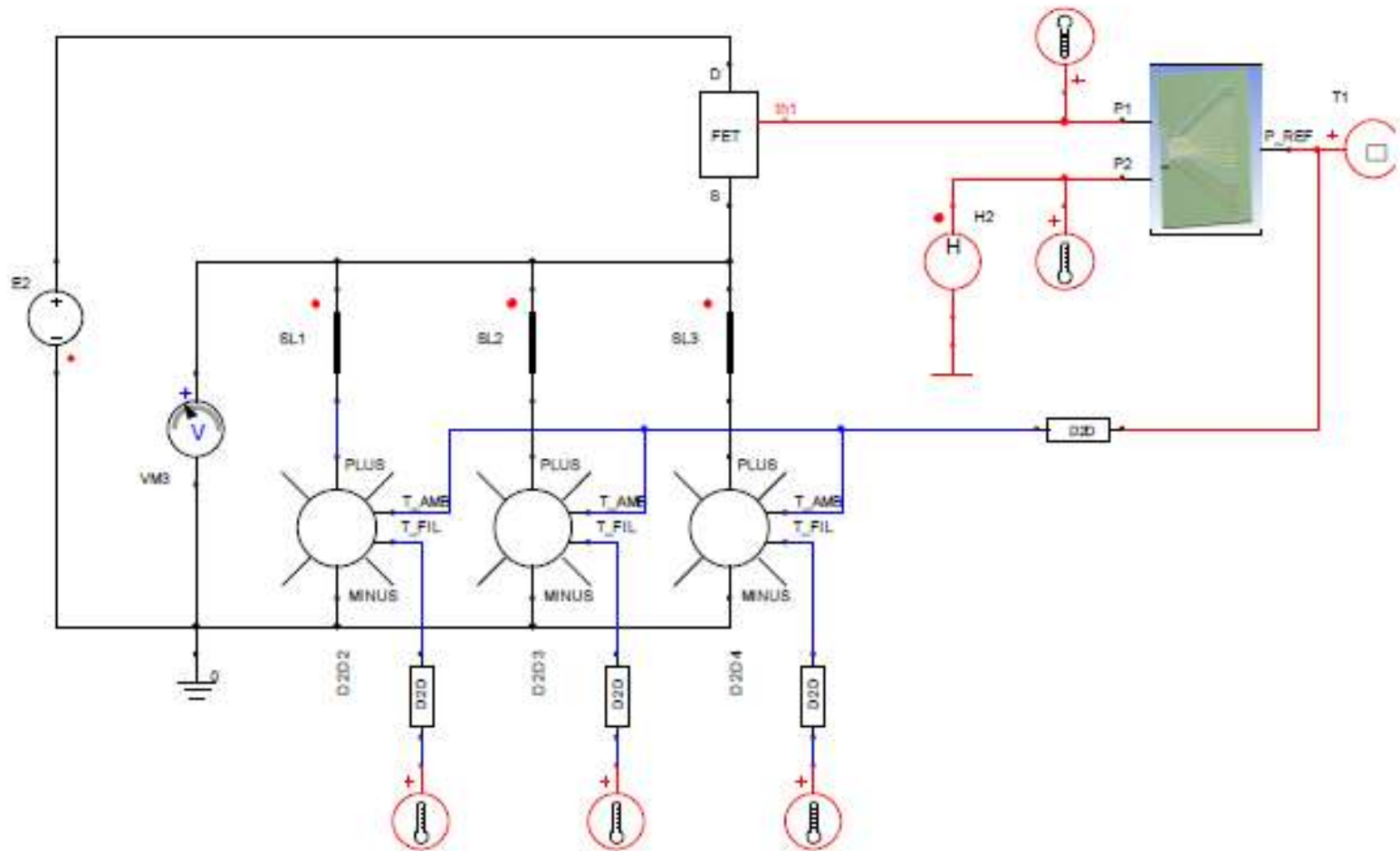
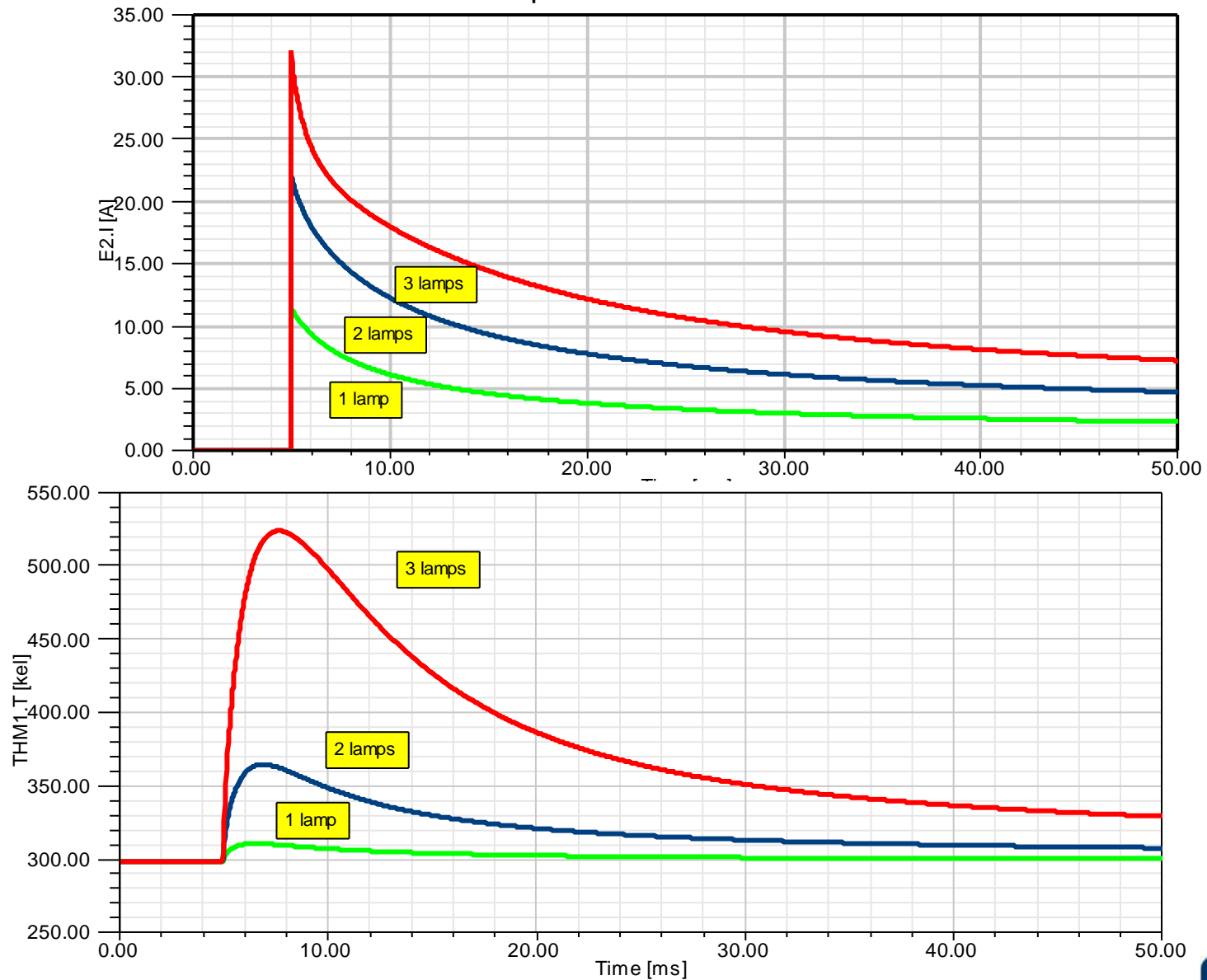


Fig. 13. Transient junction temperature curves as a function of dc loading level
 $T_A = 25^\circ$, $k = 3.5e-4$, $R_\theta = 35m\Omega$, $T_\theta = 25^\circ C$,

Transient Turn-on of an Automotive Light-Bulb



Transient Turn-on of an Automotive Light-Bulb



Example of Mechanical System

Lehrstuhl für Regelungstechnik
Fakultät für Maschinenwesen
Technische Universität München

Aktive Schwingungsisolierung in Kfz-Motoraufhängungen –
Systemkonfiguration und Methoden

Jörg Paschedag

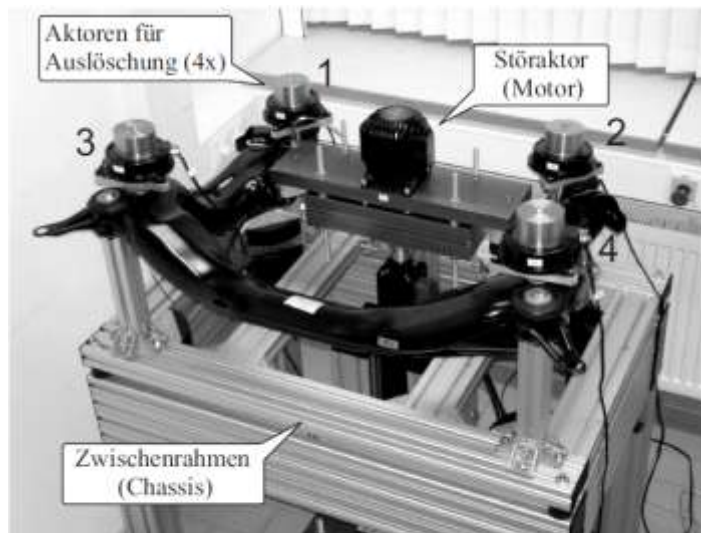


Bild 4.6: Vollständiger Mehrkanalprüfstand



Bild 4.1: Motoraufhängung im Audi A6

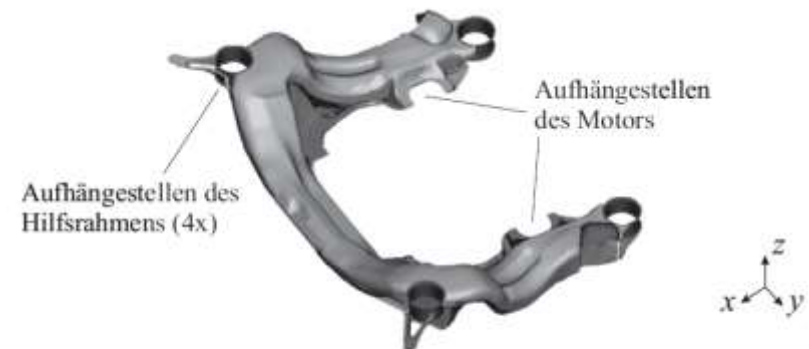
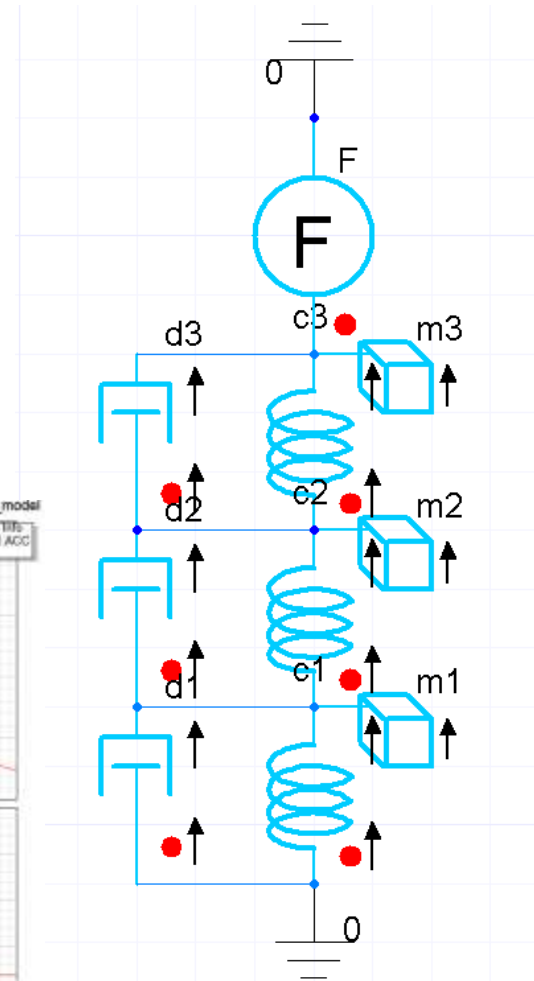
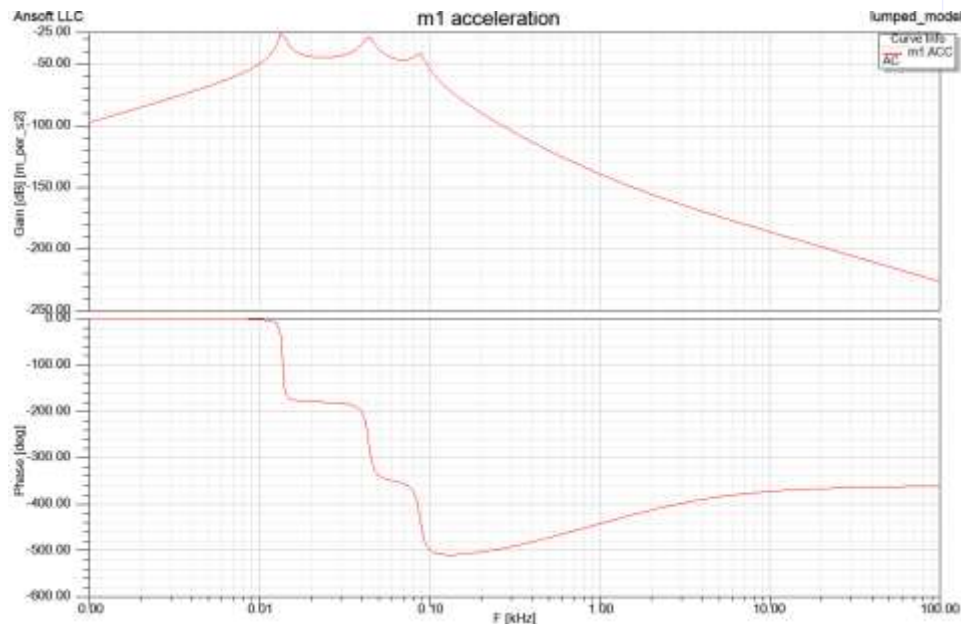
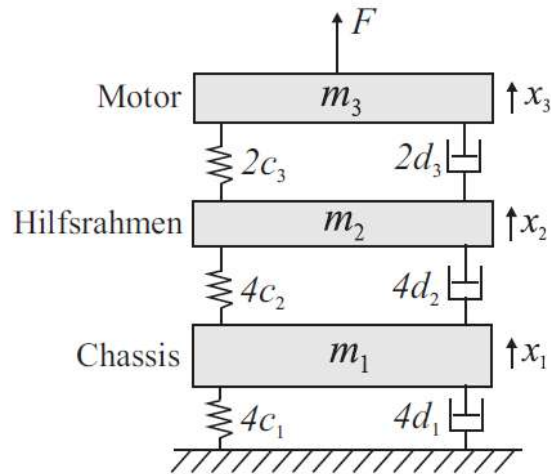


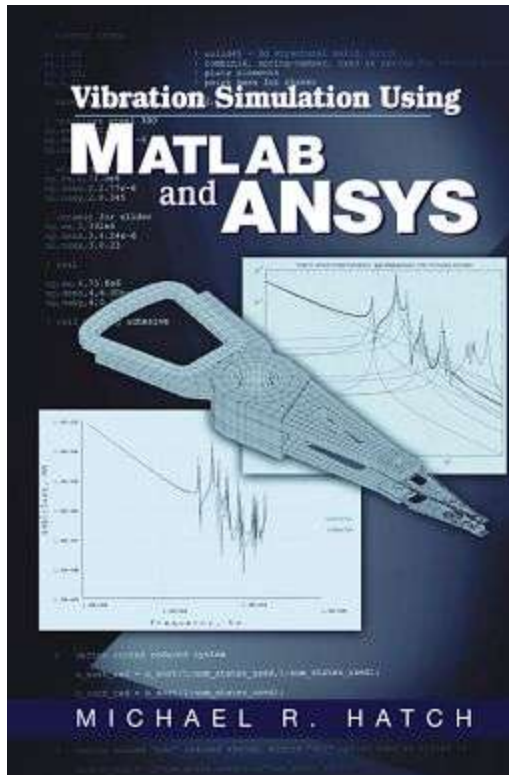
Bild 4.2: Hilfsrahmen mit Lagerstellen

System Level Simulation



Hard Disk Drive Actuator/Suspension System

- Michael R Hatch, Vibration Simulation Using MATLAB and ANSYS



Michael R. Hatch

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DOWNLOADS

All computer files available for download from this web site are zipped into one file (hatch.zip). These files are meant as a companion to Mike Hatch's book *Vibration Simulation Using MATLAB and ANSYS*. In order to unzip this file you must use an unzip utility such as WinZip.

- HATCH.ZIP
- DOCUMENTATION

Hatch.zip was last updated on March 16, 2002.

Although the documentation is included in *readme.m* in the zip file, it is also available for viewing by clicking on the text link to the right. The accompanying DOCUMENTATION provides a description of all files included in the zip file.

Before you can download the zip file, you must have read all legal information associated with the program. Consequently, when you click on HATCH.ZIP you will be forwarded to the legal page. Please follow the instructions provided on that page.

Last Updated April 09, 2006
Copyright © 2000-2009 Michael R. Hatch
Web Site Design by Galganov

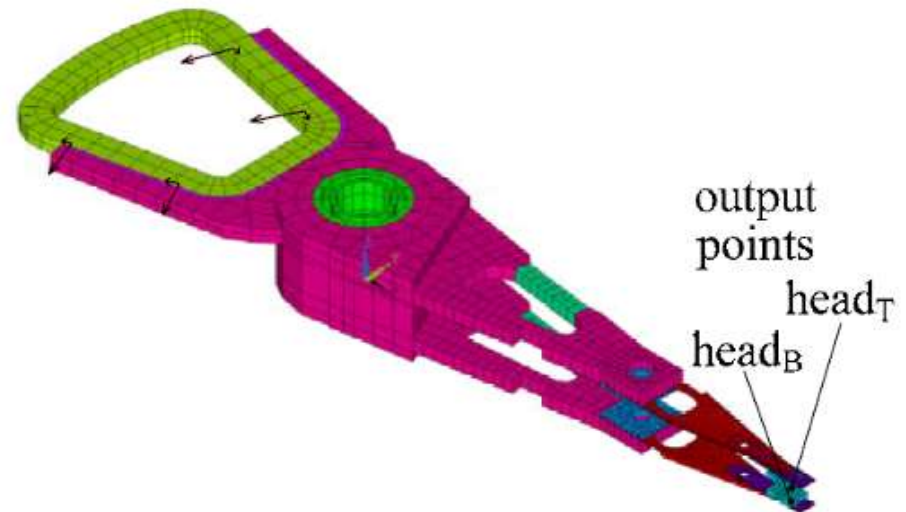
Model Reduction

- 3352 elements
- 7344 nodes
- 21227 equation

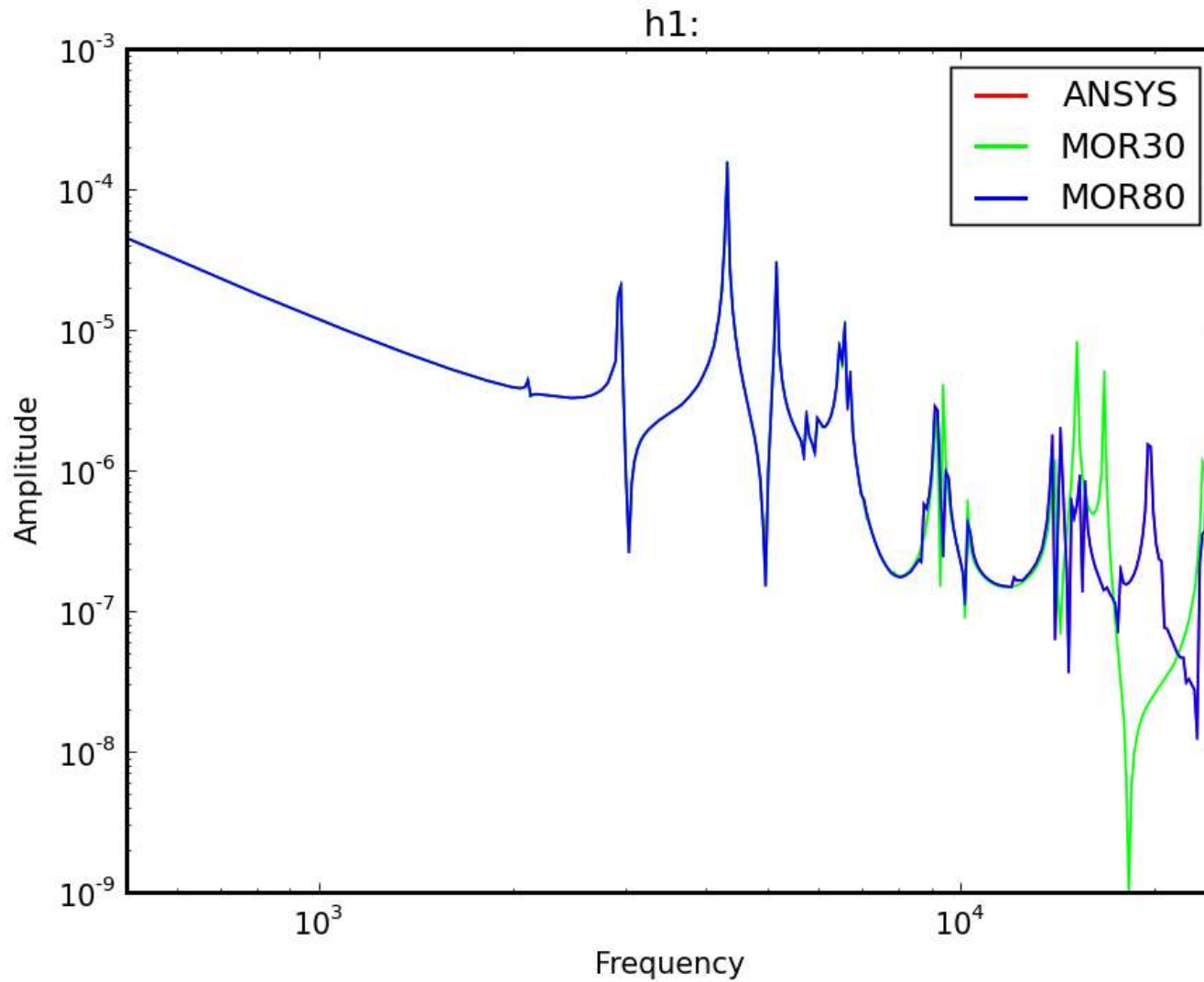
- 400 frequencies takes about 12 min

- MOR takes only 3 s

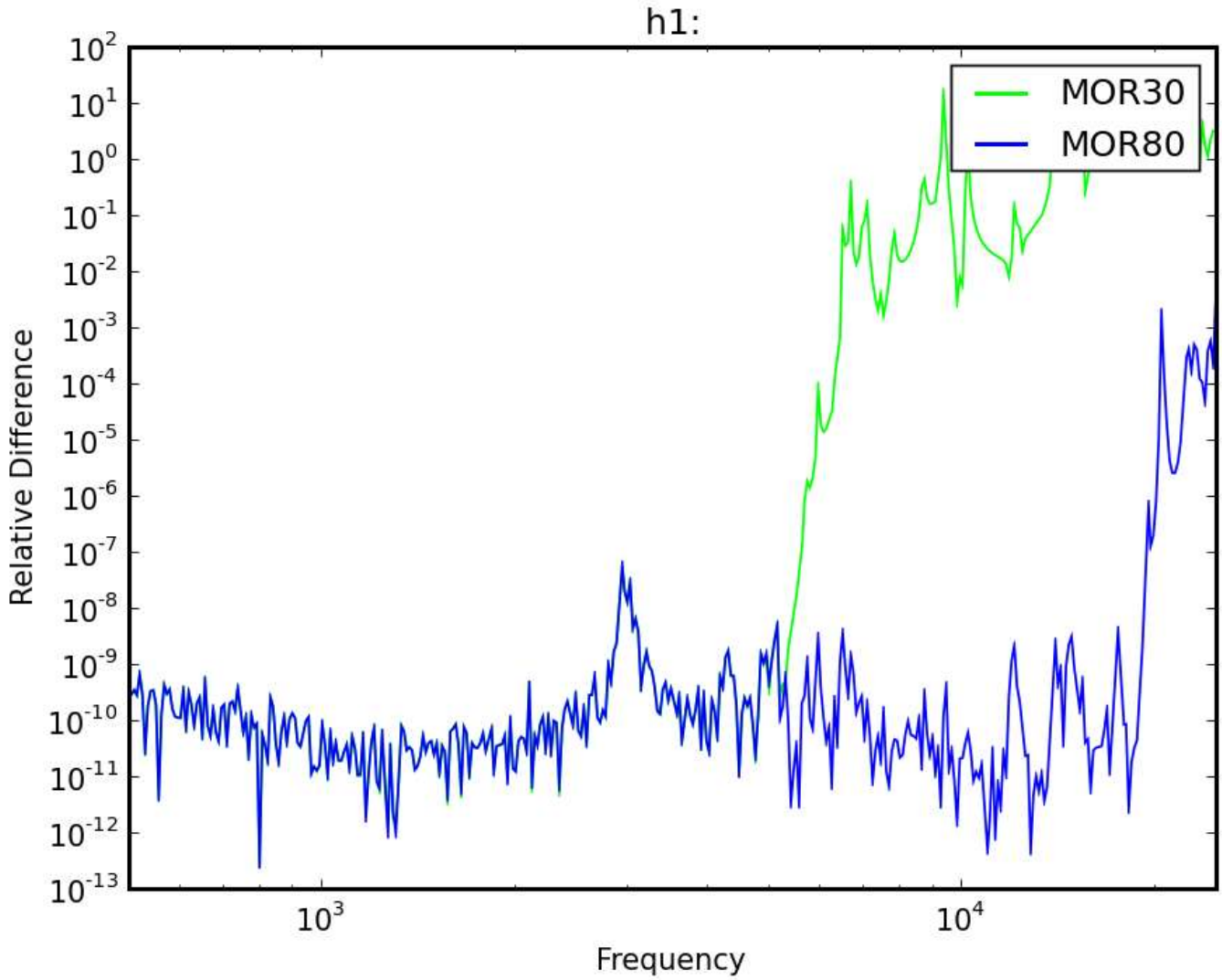
- Comparison for head
 - ANSYS
 - MOR 30
 - MOR 80



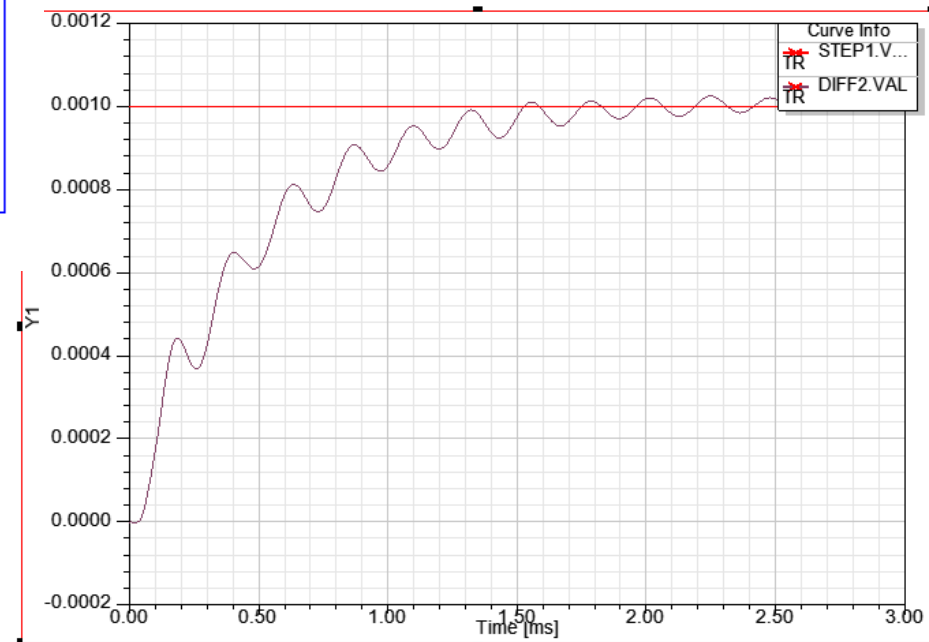
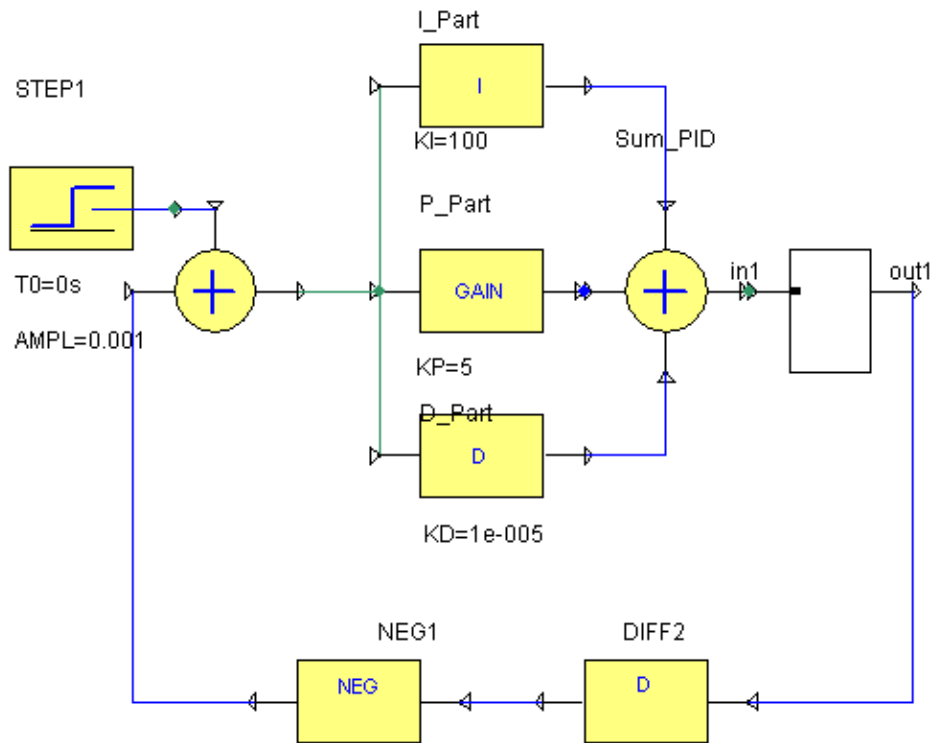
Comparison



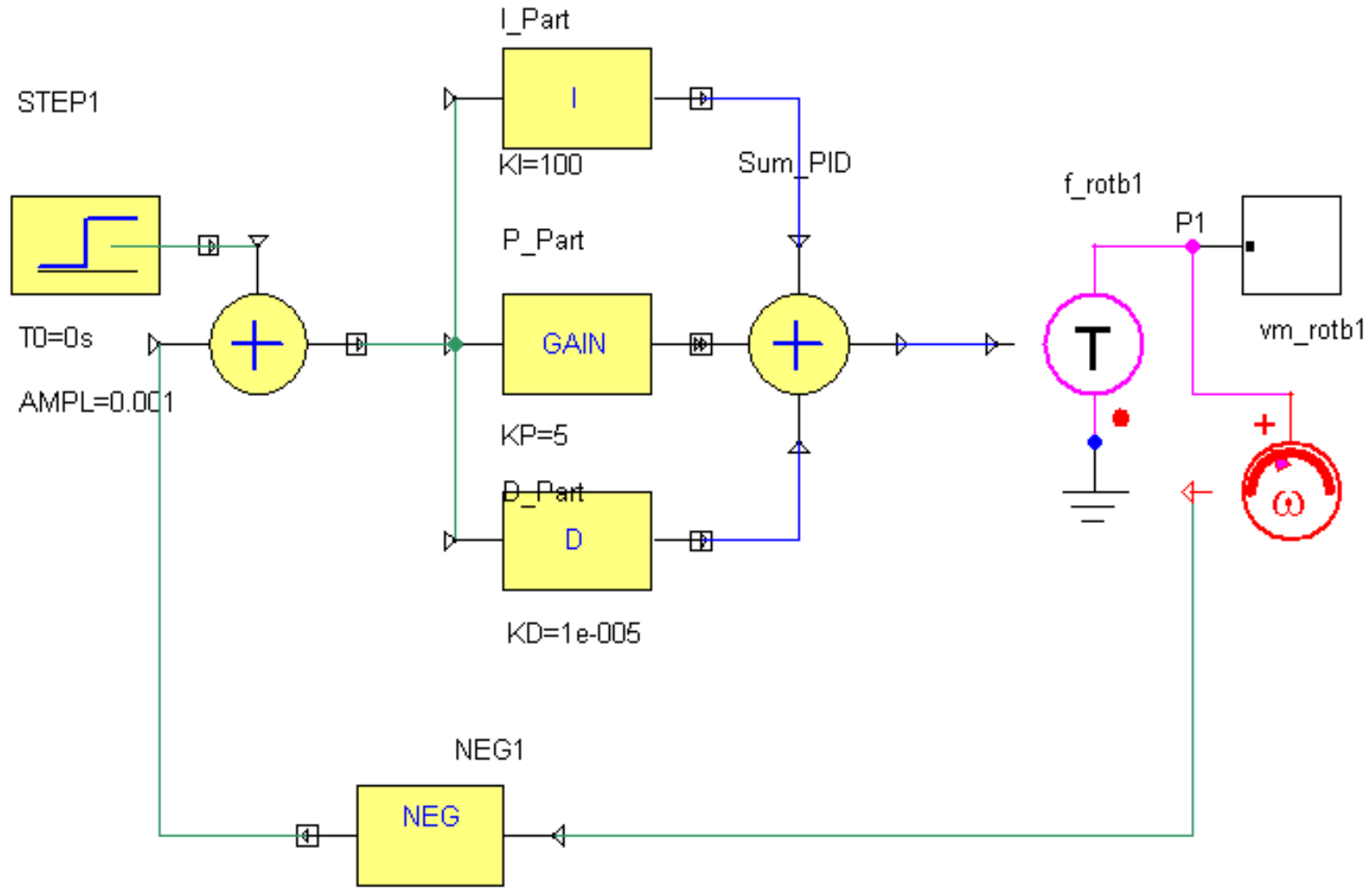
Comparison



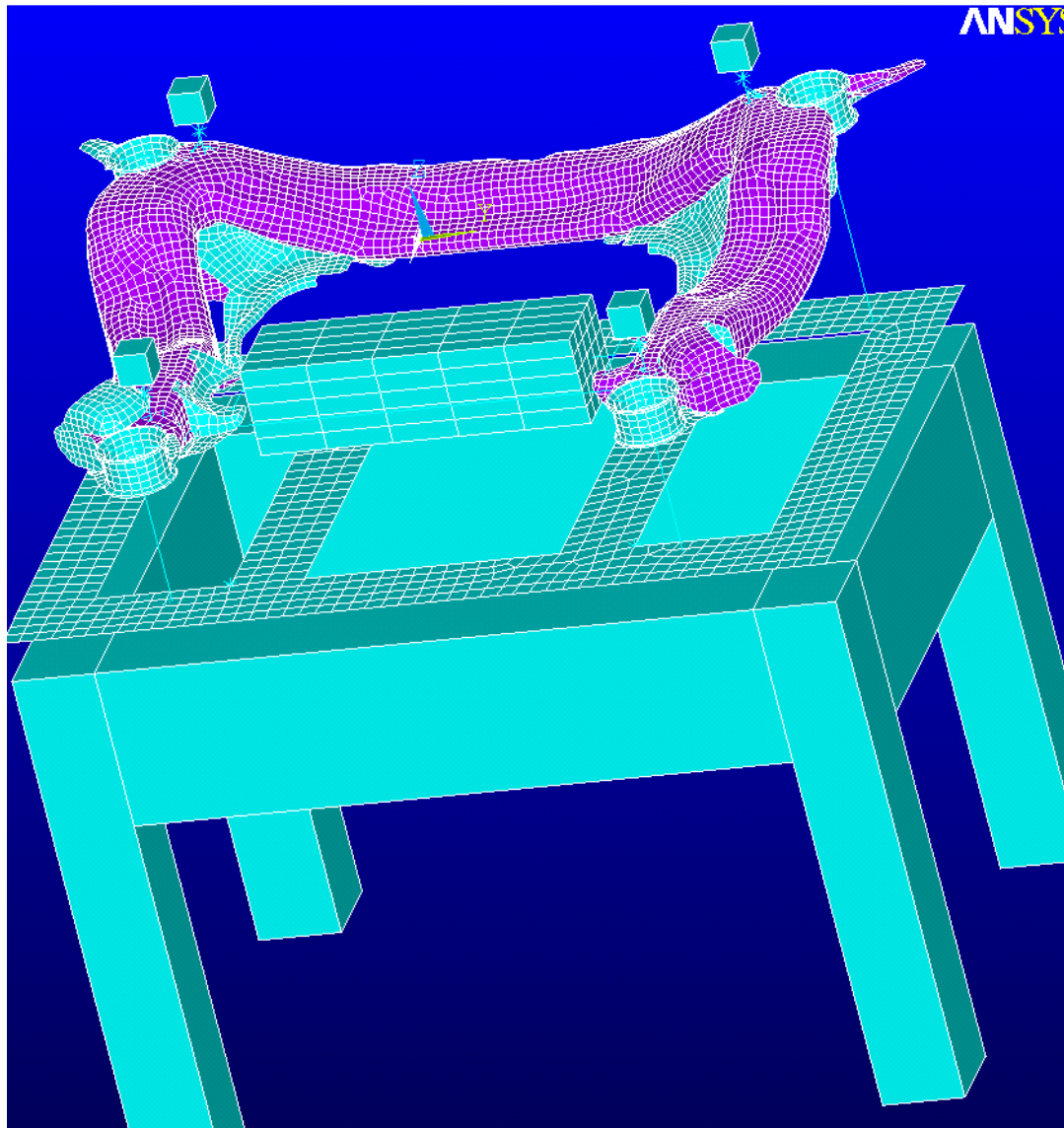
Velocity Control: Device as a Black Box



Velocity Control: Multiphysics Modeling

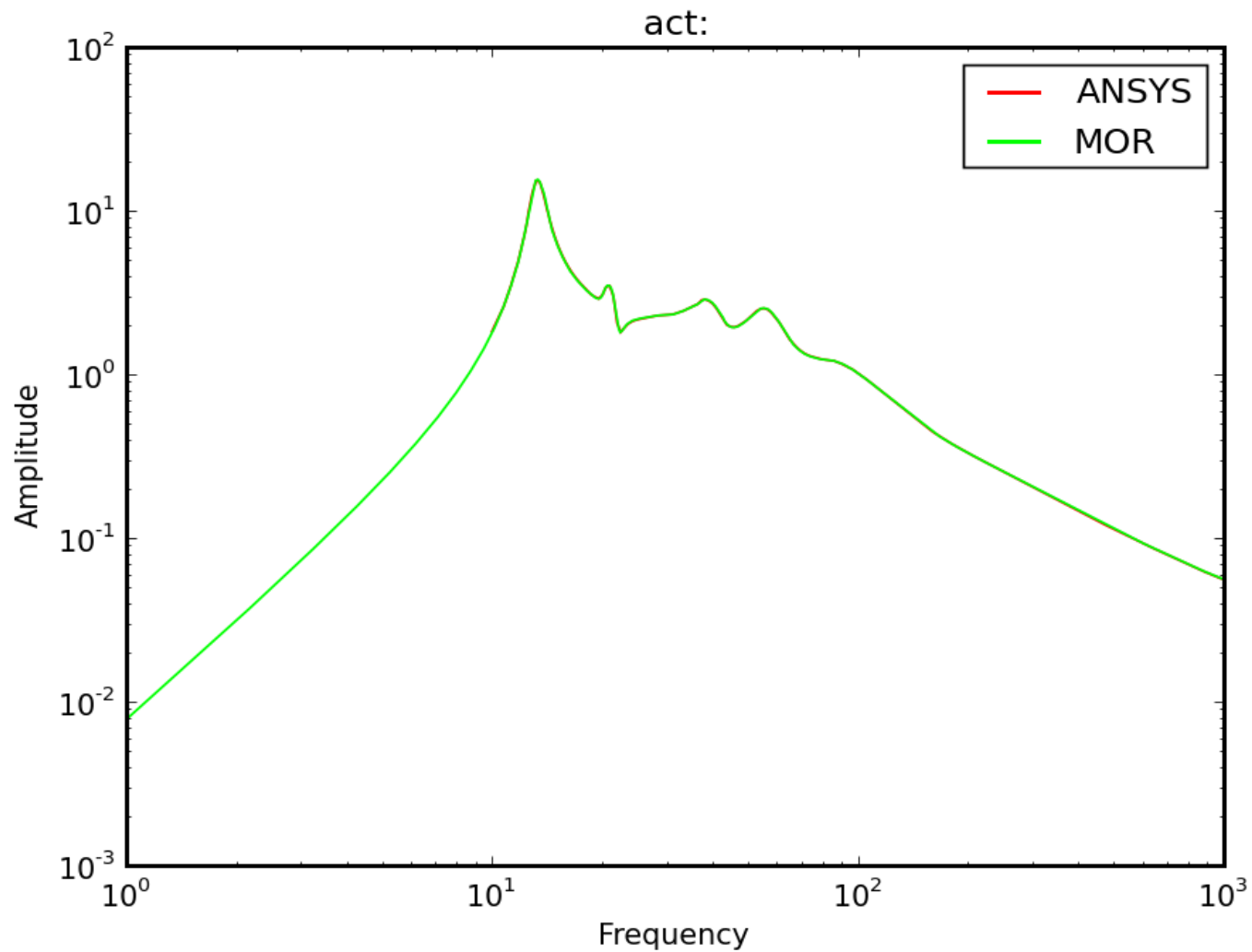


Model Reduction for the FEM Model



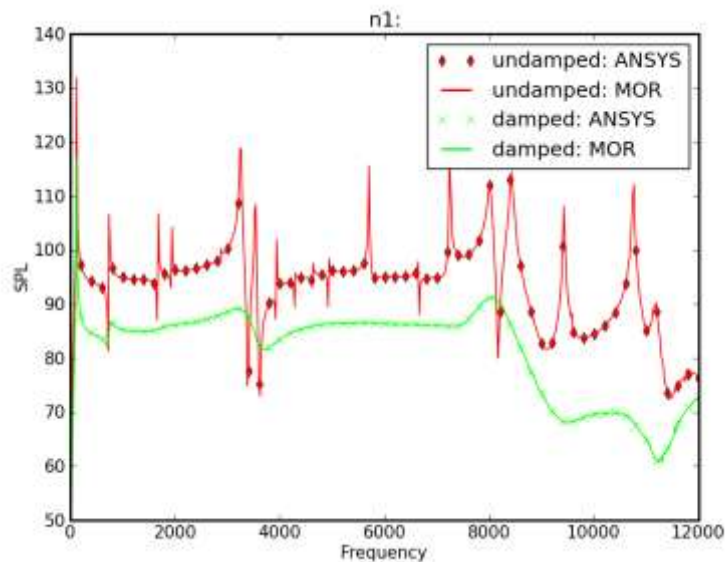
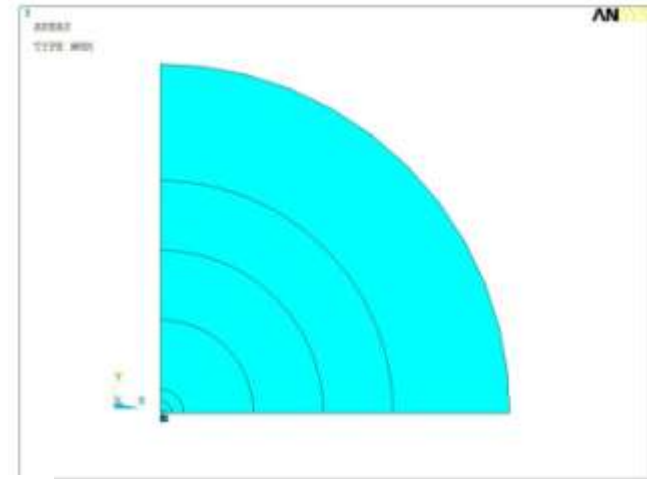
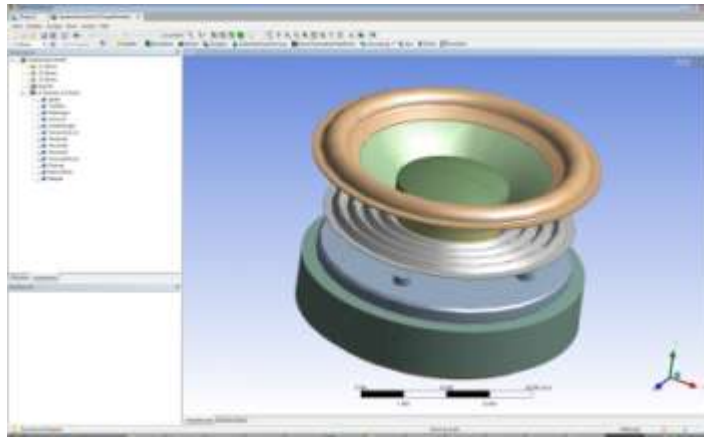
- 13 347 elements
- 11 765 nodes
- 55 481 equations to solve
- 200 frequencies takes about 20 min
- Model reduction takes 8 second

Comparison



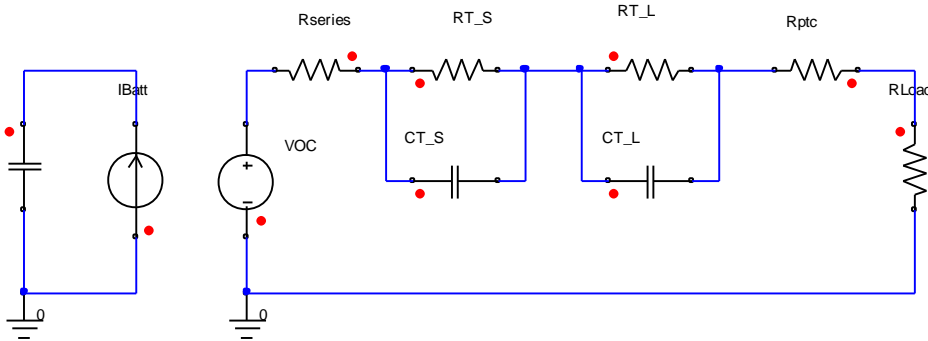
Efficient Simulation of Acoustic FSI

- Wednesday 17:00 - 17:20, CADFEM + Simetris

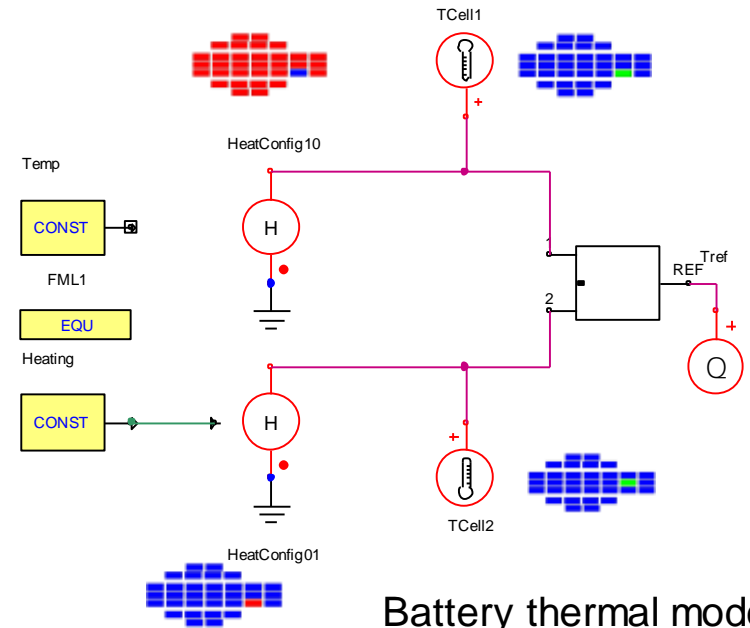
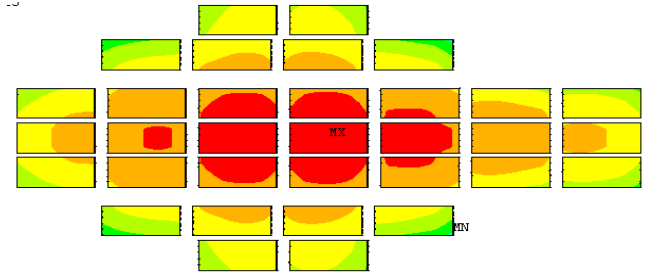


System Level Battery Thermal Behavior Study

- Thursday, 12:20 - 12:40, CADFEM



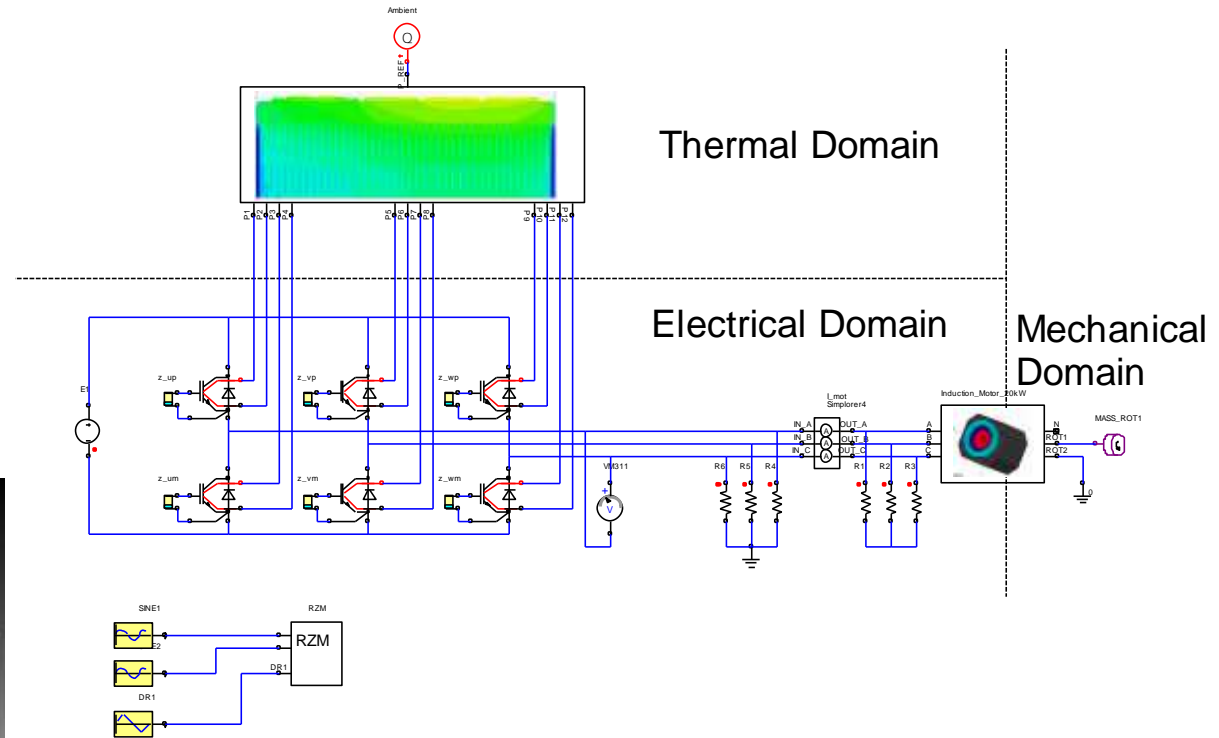
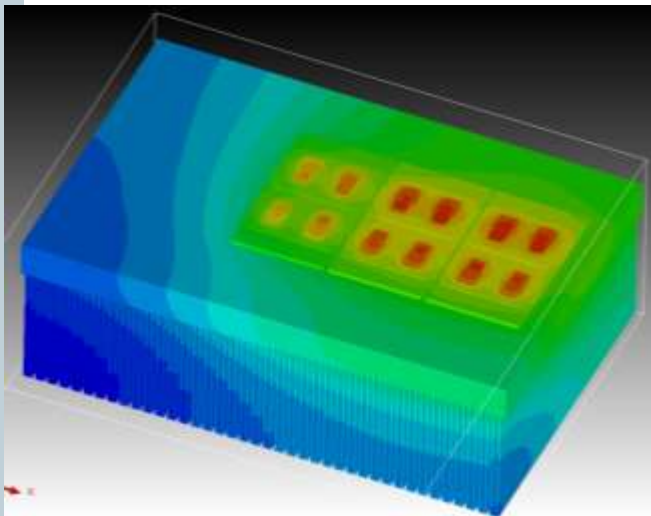
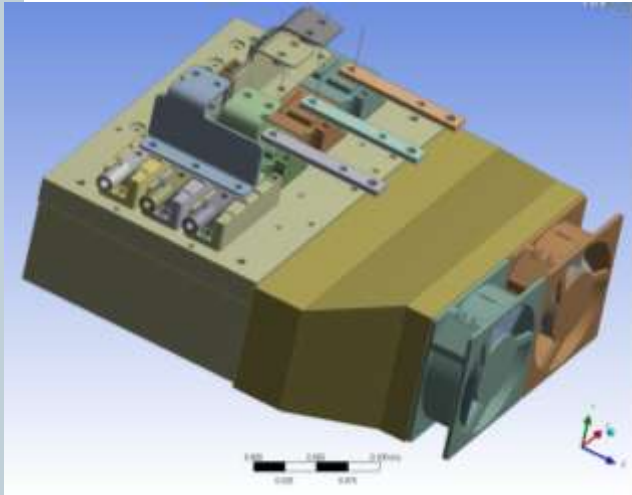
Electrical cell model
(cell1)



Battery thermal model

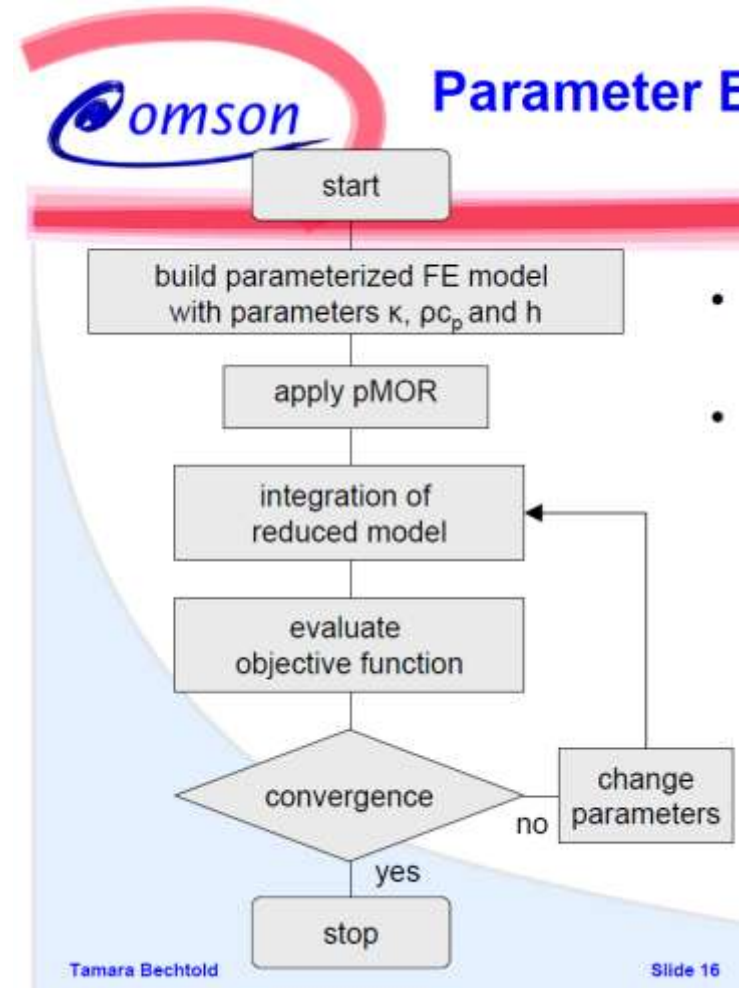
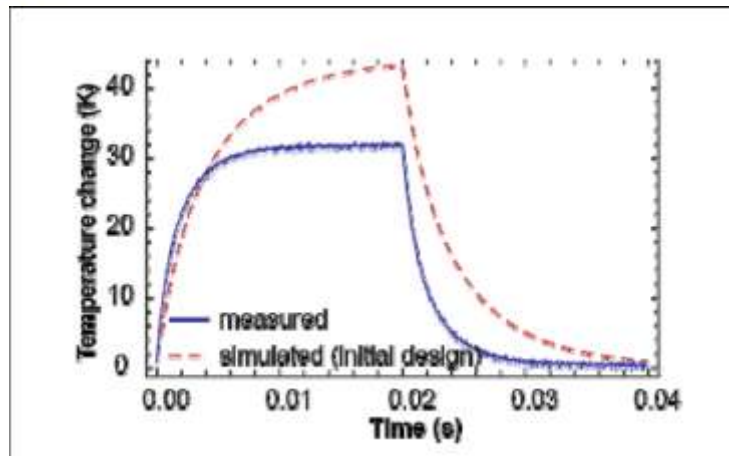
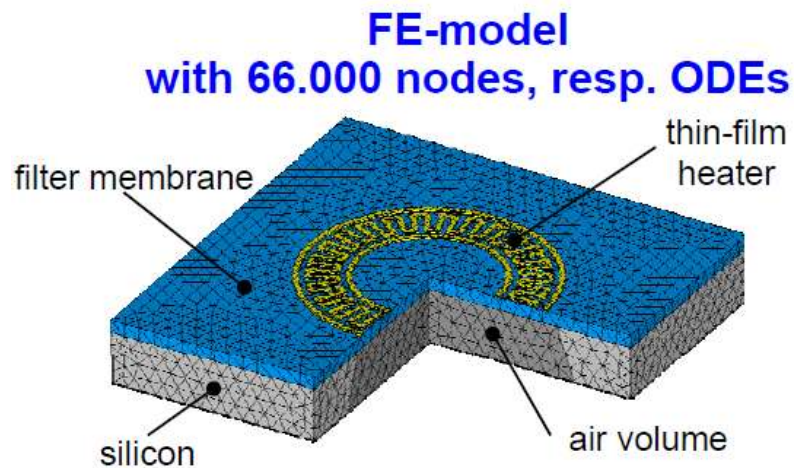
Elektrothermische Simulation eines IGBT Wechselrichters

- Thursday 11:40 – 12:20, CADFEM + ANSOFT



Extraction of Thermal Properties of Thin Films

- Thursday, 12:20 - 12:40, T. Bechtold, NXP
 - Parametric Model Reduction



Also on Thursday

- 16:20 - 16:40, Export von modal reduzierten Körpern aus ANSYS und deren Echtzeitberechnung, P. Sekler, A. Dadalau
- 17:00 - 17:20 Application of MOR for ANSYS to Hydro Turbine Runner Dynamics, F. Lippold (Voith Hydro Holding GmbH & Co. KG, Heidenheim)
- 17:00 - 17:20 Zustandsraumbeschreibung von piezo-mechanischen Systemen auf Grundlage einer Finite-Elemente-Diskretisierung, B. Kranz (Fraunhofer-Institut IWU, Dresden)
- 17:20 - 17:40 Parametric Reduction of Multiphysics Models, J. Mohring (Fraunhofer-Institut ITWM, Kaiserslautern)
- 17:40 - 18:00 Novel Model Reduction Techniques for Control of Machine Tools, P. Benner (Technische Universität Chemnitz)

Conclusion

- ANSYS – device level model
- Simplorer – system level simulation
- MOR for ANSYS – model reduction for ANSYS models